

- ☐ Tentative Specification
- ☐ Preliminary Specification
- ☒ Approval Specification

MODEL NO.: V500HK1
SUFFIX: LS5

Customer:

APPROVED BY

SIGNATURE

Name / Title

Note

Please return 1 copy for your confirmation with your signature and comments.

Approved By	Checked By	Prepared By
Chao-Chun Chung	Ken Wu	WT Hsu

**CONTENTS**

1. GENERAL DESCRIPTION	5
1.1 OVERVIEW	5
1.2 FEATURES	5
1.3 APPLICATION	5
1.4 GENERAL SPECIFICATIONS	5
1.5 MECHANICAL SPECIFICATIONS	6
2. ABSOLUTE MAXIMUM RATINGS	7
2.1 ABSOLUTE RATINGS OF ENVIRONMENT	7
2.2 PACKAGE STORAGE	8
2.3 ELECTRICAL ABSOLUTE RATINGS	8
2.3.1 TFT LCD MODULE	8
2.3.2 BACKLIGHT CONVERTER UNIT	8
3. ELECTRICAL CHARACTERISTICS	9
3.1 TFT LCD MODULE	9
3.2 BACKLIGHT UNIT	12
3.2.1 LED LIGHT BAR CHARACTERISTICS ($T_a = 25 \pm 2^\circ\text{C}$)	12
3.2.2 CONVERTER CHARACTERISTICS ($T_a = 25 \pm 2^\circ\text{C}$)	12
3.2.3 CONVERTER INTERFACE CHARACTERISTICS	14
4. BLOCK DIAGRAM OF INTERFACE	16
4.1 TFT LCD MODULE	16
5. INPUT TERMINAL PIN ASSIGNMENT	17
5.1 TFT LCD MODULE	17
5.2 BACKLIGHT UNIT	22
5.3 DRIVING BOARD UNIT	22
5.4 BLOCK DIAGRAM OF INTERFACE	23
6. INTERFACE TIMING	29
6.1 INPUT SIGNAL TIMING SPECIFICATIONS ($T_a = 25 \pm 2^\circ\text{C}$)	29
6.2 POWER ON/OFF SEQUENCE	34
6.2.1 POWER ON/OFF SEQUENCE	34
6.2.2 2D/3D MODE CHANGE SIGNAL SEQUENCE WITHOUT VCC TURN OFF AND TURN ON	35



7. OPTICAL CHARACTERISTICS	36
7.1 TEST CONDITIONS.....	36
7.2 OPTICAL SPECIFICATIONS	37
8. DEFINITION OF LABELS.....	43
8.1 CMI MODULE LABEL	43
9. Packaging	44
9.1 PACKING SPECIFICATIONS.....	44
9.2 PACKING METHOD.....	44
10. PRECAUTIONS.....	46
10.1 ASSEMBLY AND HANDLING PRECAUTIONS	46
10.2 SAFETY PRECAUTIONS	46
10.3 SAFETY STANDARDS	46
11. MECHANICAL CHARACTERISTIC.....	47

**REVISION HISTORY**

Version	Date	Page (New)	Section	Description
A1	Sep.19,11	all	all	Tentative Specification Ver 0.0 was first issued.
A1	Sep.23,11	48	11	Update MECHANICAL CHARACTERISTIC
B3	Oct 26,11	5	1.1	Update OVERVIEW
		5	1.2	Update FEATURES
		6	1.5	Update MECHANICAL SPECIFICATIONS
		8	2.3.2	Update BACKLIGHT CONVERTER UNIT
		9	3.1	Update TFT LCD MODULE
		12	3.2.1	Update LED LIGHT BARCHARACTERISTICS
		12~13	3.2.2	Update CONVERTER CHARACTERISTICS
		14	3.2.3	Update CONVERTER INTERFACE CHARACTERISTICS
		16	4.1	Update TFT LCD MODULE
		17~19	5.1	Update TFT LCD MODULE
		23~24	5.4	Update BLOCK DIAGRAM OF INTERFACE
		25~26	5.5	Update LVDS INTERFACE
		27	5.6	Update COLOR DATA INPUT ASSIGNMENT
		29~30	6.1	Update INPUT SIGNAL TIMING SPECIFICATIONS
		34	6.2.2	Update 2D/3D MODE CHANGE SIGNAL SEQUENCE WITHOUT VCC TURN OFF AND TURN ON
C3	Nov.25,11	35	7.1	Update TEST CONDITIONS
		36、39、41	7.2	Update OPTICAL SPECIFICATIONS
		9	3.1	Update TFT LCD MODULE
		16	4.1	Update TFT LCD MODULE
		20~21	5.1	Update Note (9)& Note (12) of TFT LCD MODULE
		22	5.2	Update BACKLIGHT UNIT
		29	6.1	Update INPUT SIGNAL TIMING SPECIFICATIONS (Ta = 25 ± 2 °C)
		33	6.1.2	Update Notes(5) of Timing spec for Frame Rate = 60Hz
		35	6.2.2	Update 2D/3D MODE CHANGE SIGNAL SEQUENCE WITHOUT VCC TURN OFF AND TURN ON
		36	7.1	Update TEST CONDITIONS
		37	7.2	Update OPTICAL SPECIFICATIONS & Notes(4)、(5)、(6)、(8)
		44	9.1	Update PACKING SPECIFICATIONS
		47~48	11	Update MECHANICAL CHARACTERISTIC

1. GENERAL DESCRIPTION

1.1 OVERVIEW

V500HK1-LS5 is a 50" TFT Liquid Crystal Display module with LED Backlight unit and 2ch-LVDS interface.

This module supports 1920 x 1080 HDTV format and can display true 16.7M colors (8-bit + Hi-FRC /color).

The driving board module for backlight is built-in.

1.2 FEATURES

- High brightness 400nits
- High contrast ratio 5000:1
- Fast response time Gray to Gray typical 6ms
- High color saturation 72% NTSC
- Full HDTV (1920 x 1080 pixels) resolution, true HDTV format
- DE (Data Enable) only mode
- LVDS (Low Voltage Differential Signaling) interface
- Optimized response time for 120 Hz frame rate
- Ultra wide viewing angle: Super MVA technology
- RoHs compliance

1.3 APPLICATION

- Standard Living Room TVs.
- Public Display Application.
- Home Theater Application.
- MFM Application.

1.4 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Active Area	1095.84(H) x (V) 616.41 (50" diagonal)	mm	(1)
Bezel Opening Area	1102.84(H) x 623.41(V)	mm	
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920 x R.G.B. x 1080	pixel	-
Pixel Pitch(Sub Pixel)	0.1903(H) x 0.5708(V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	16.7M	color	-
Display Operation Mode	Transmissive mode / Normally black	-	-
Surface Treatment	Anti-Glare coating (3.5% Low Haze)	-	(2)

Note (1) Please refer to the attached drawings in chapter 9 for more information about the front and back outlines.

Note (2) The spec of the surface treatment is temporarily for this phase. CMI reserves the rights to change this feature.

**1.5 MECHANICAL SPECIFICATIONS**

Item		Min.	Typ.	Max.	Unit	Note
Module Size Weight	Horizontal (H)	1121.14	1122.64	1124.14	mm	Module Size
	Vertical (V)	643.81	645.31	646.81	mm	
	Depth (D)	14.1	15.1	16.1	mm	To Rear
		23	24	25	mm	To converter cover
	Weight		14000		G	Weight

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

Note (2) Module Depth does not include connectors.

2. ABSOLUTE MAXIMUM RATINGS**2.1 ABSOLUTE RATINGS OF ENVIRONMENT**

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	T _{ST}	-20	+60	°C	(1)
Operating Ambient Temperature	T _{OP}	0	50	°C	(1), (2)
Shock (Non-Operating)	S _{NOP}	-	35	G	(3), (5)
Vibration (Non-Operating)	V _{NOP}	-	1.0	G	(4), (5)

Note (1) Temperature and relative humidity range is shown in the figure below.

(a) 90 %RH Max. ($T_a \leq 40\text{ }^{\circ}\text{C}$).

(b) Wet-bulb temperature should be 39 °C Max. ($T_a > 40\text{ }^{\circ}\text{C}$).

(c) No condensation.

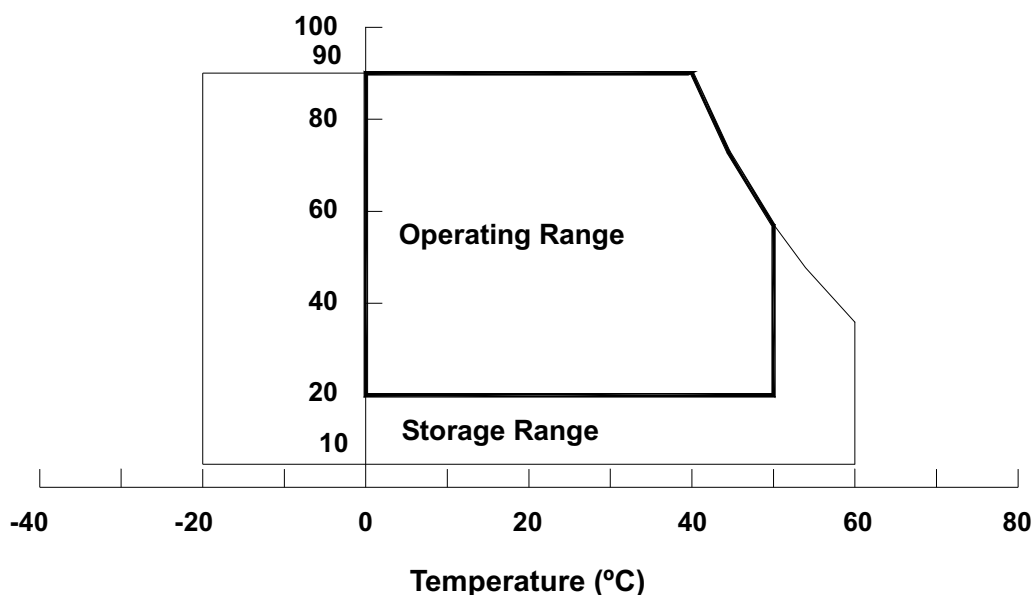
Note (2) The maximum operating temperature is based on the test condition that the surface temperature of display area is less than or equal to 65 °C with LCD module alone in a temperature controlled chamber. Thermal management should be considered in final product design to prevent the surface temperature of display area from being over 65 °C. The range of operating temperature may degrade in case of improper thermal management in final product design.

Note (3) 11 ms, half sine wave, 1 time for $\pm X$, $\pm Y$, $\pm Z$.

Note (4) 10 ~ 200 Hz, 30 min, 1 time each X, Y, Z.

Note (5) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

Relative Humidity (%RH)



2.2 PACKAGE STORAGE

When storing modules as spares for a long time, the following precaution is necessary.

- (a) Do not leave the module in high temperature, and high humidity for a long time, It is highly recommended to store the module with temperature from 0 to 35 °C at normal humidity without condensation.
- (b) The module shall be stored in dark place. Do not store the TFT-LCD module in direct sunlight or fluorescent light.

2.3 ELECTRICAL ABSOLUTE RATINGS**2.3.1 TFT LCD MODULE**

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	V _{CC}	-0.3	13.5	V	(1)
Logic Input Voltage	V _{IN}	-0.3	3.6	V	

2.3.2 BACKLIGHT CONVERTER UNIT

Item	Symbol	Test Condition	Min.	Type	Max.	Unit	Note
Light Bar Voltage	V _W	Ta = 25 °C	-	-	58.8	V _{RMS}	3D Mode
Converter Input Voltage	V _{BL}	-	0	-	30	V	
Control Signal Level	-	-	-0.3	-	7	V	

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

Note (2) No moisture condensation or freezing.

Note (3) The control signals include On/Off Control and External PWM Control.

3. ELECTRICAL CHARACTERISTICS

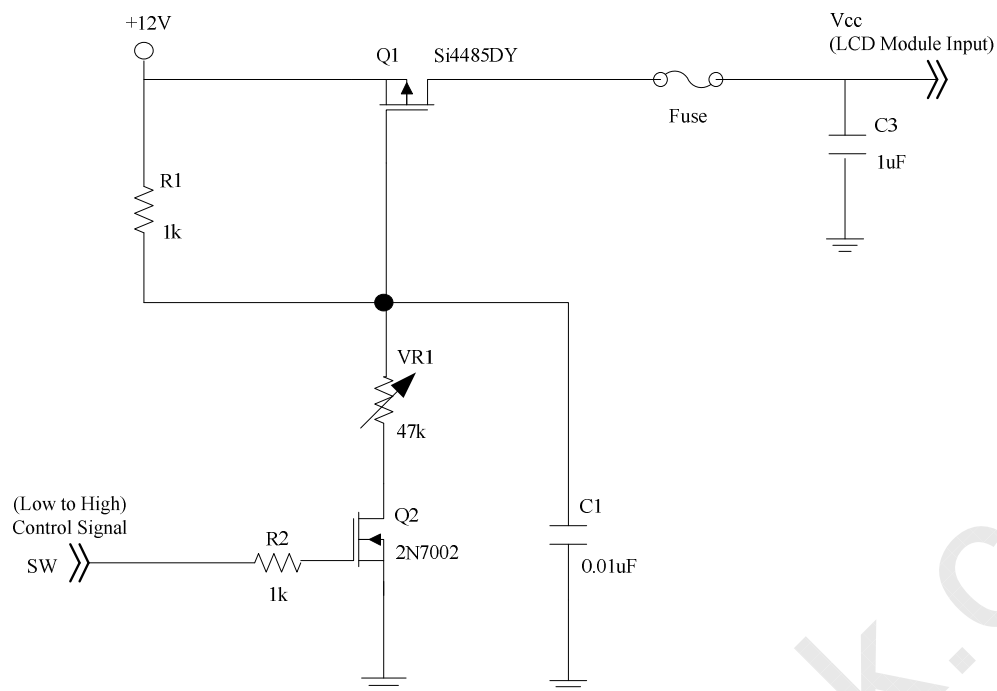
3.1 TFT LCD MODULE

(Ta = 25 ± 2 °C)

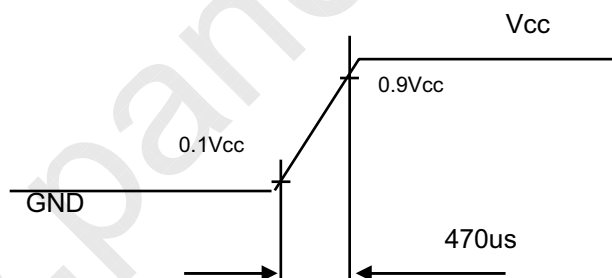
Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Power Supply Voltage		V _{CC}	10.8	12	13.2	V	(1)
Rush Current		I _{RUSH}	—	—	3.06	A	(2)
Power Consumption	White Pattern	—	—	6.6	7.1	W	(3)
	Horizontal Stripe	—	—	14	18.1	W	
	Black Pattern	—	—	6.5	7.0	W	
Power Supply Current	White Pattern	—	—	0.55	0.60	A	
	Horizontal Stripe	—	—	1.2	1.5	A	
	Black Pattern	—	—	0.54	0.59	A	
LVDS interface	Differential Input High Threshold Voltage	V _{LVTH}	+100	—	—	mV	(4)
	Differential Input Low Threshold Voltage	V _{LVTL}	—	—	-100	mV	
	Common Input Voltage	V _{CM}	1.0	1.2	1.4	V	
	Differential input voltage (single-end)	V _{ID}	200	—	600	mV	
	Terminating Resistor	R _T	—	100	—	ohm	
CMIS interface	Input High Threshold Voltage	V _{IH}	2.7	—	3.3	V	
	Input Low Threshold Voltage	V _{IL}	0	—	0.7	V	

Note (1) The module should be always operated within the above ranges.

Note (2) Measurement condition:



Vcc rising time is 470us



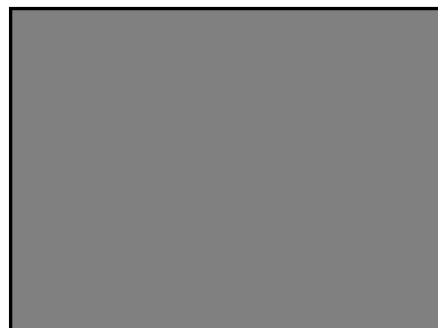
Note (3) The specified power consumption and power supply current is under the conditions at $V_{cc} = 12\text{ V}$, $T_a = 25 \pm 2\text{ }^{\circ}\text{C}$, $f_v = 120\text{ Hz}$, whereas a power dissipation check pattern below is displayed.

a. White Pattern



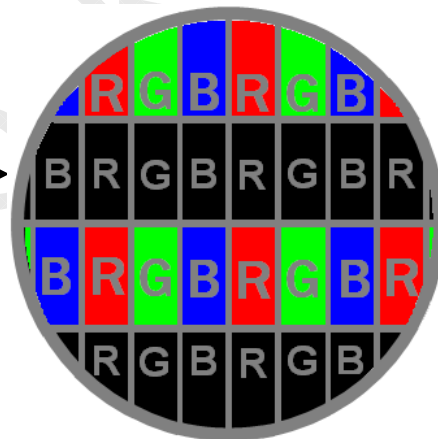
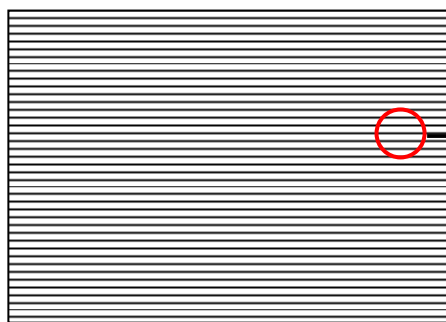
Active Area

b. Black Pattern

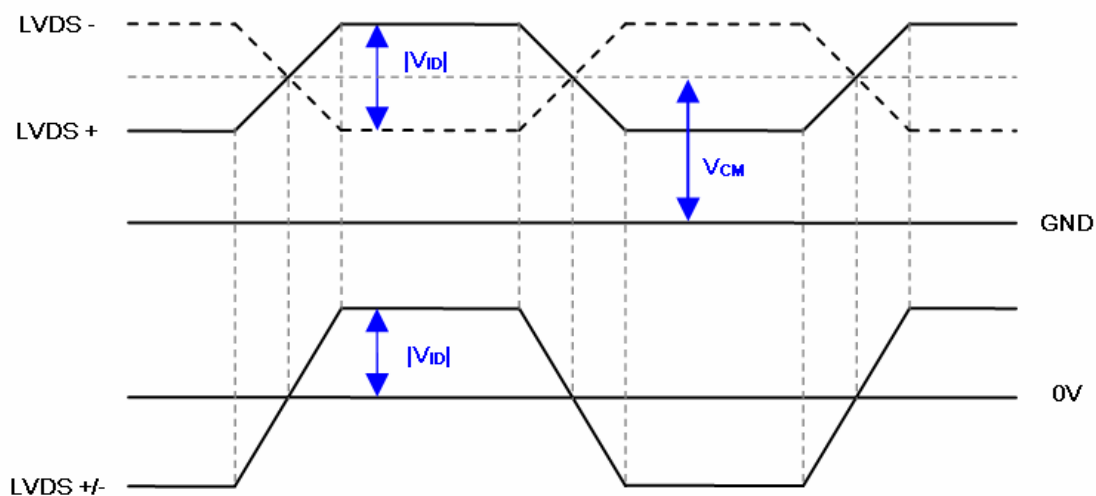


Active Area

c. Horizontal Pattern



Note (4) The LVDS input characteristics are as follows:



3.2 BACKLIGHT UNIT

3.2.1 LED LIGHT BAR CHARACTERISTICS (Ta = 25 ± 2 °C)

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Total Current (16 String)	If	-	1840	1952	mA	
One String Current	IL(2D)	-	115	122	mA	
	IL(3D)	-	450	477	mApeak	3D ENA=ON
LED Forward Voltage	Vf	5.5	6.15	7	VDC	IL = 115mA
One String Voltage	VW	44	-	56	VDC	IL = 115mA
One String Voltage Variation	ΔVW	-	-	2	V	
Life time	-	30,000	-	-	Hrs	(1)

Note (1) The lifetime is defined as the time which luminance of the LED decays to 50% compared to the initial value, Operating condition: Continuous operating at Ta = 25±2°C, IL = 115mA.

3.2.2 CONVERTER CHARACTERISTICS (Ta = 25 ± 2 °C)

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Power Consumption	PBL(2D)	-	87.3	100.4	W	(1), (2) IL = 115mA
	PBL(3D)	-	85	100	W	(1), (2) IL=450mA.
Converter Input Voltage	VBL	22.8	24.0	25.2	VDC	
Converter Input Current	IBL(2D)	—	3.64	4.2	A	Non Dimming
	IBL(3D)	—	3.54	4.2	A	
Input Inrush Current	IR(2D)	-	-	6.5	Apeak	VBL=22.8V,(IL=typ.) (3), (6)
	IR(3D)	-	-	10	Apeak	VBL=22.8V,(IL= 360mA.)(3), (6)
Dimming Frequency	FB	150	160	170	Hz	(5)
Minimum Duty Ratio	DMIN	5	10	-	%	(4), (5)

Note (1) The power supply capacity should be higher than the total converter power consumption P_{BL} .

Since the pulse width modulation (PWM) mode was applied for backlight dimming, the driving current changed as PWM duty on and off. The transient response of power supply should be considered for the changing loading when converter dimming.

Note (2) The measurement condition of Max. value is based on 50" backlight unit under input voltage 24V, average LED current 122 mA at 2D Mode (LED current 477 mA_{peak} at 3D Mode) and lighting 1 hour later.

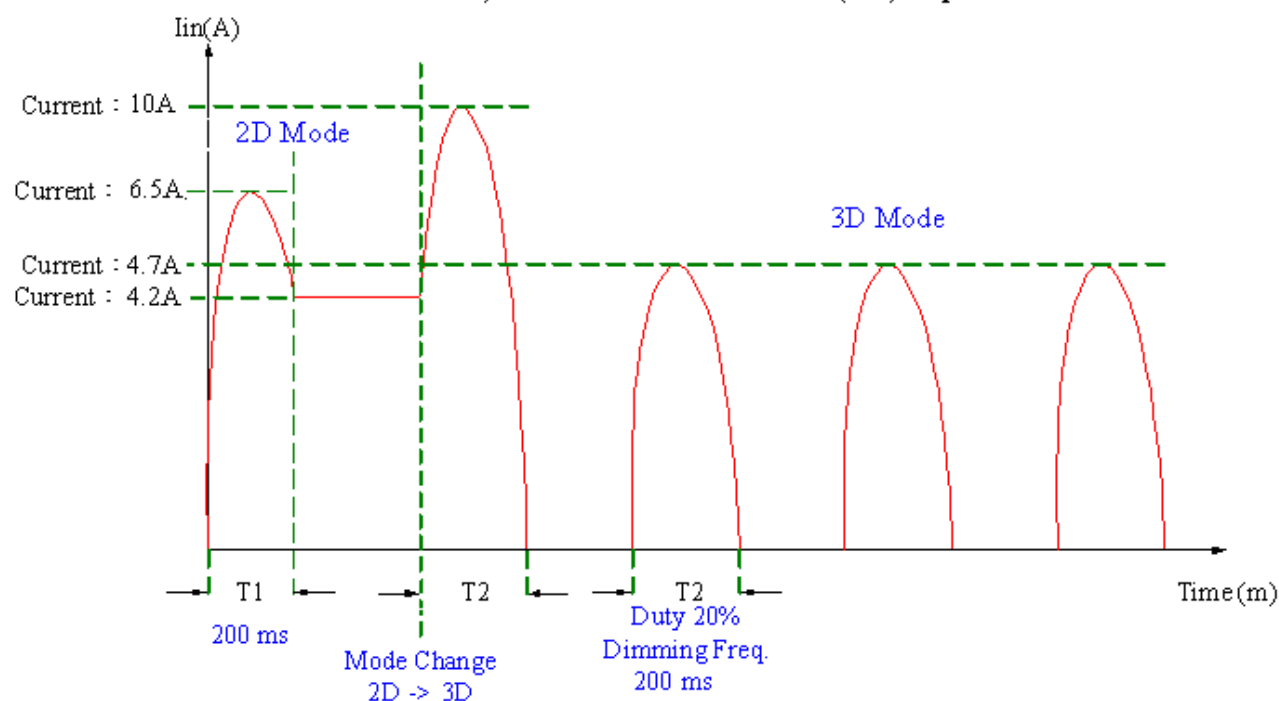
Note (3) For input inrush current measure, the VBL rising time from 10% to 90% is about 30ms.

Note (4) 5% minimum duty ratio is only valid for electrical operation.

Note (5) FB and DMIN are available only at 2D Mode.

Note (6) Below diagram is only for power supply design reference.

Test Condition: VBL=22.8V, IL=115mA at 2D Mode/IL=(450)mA_{peak} at 3D Mode.





3.2.3 CONVERTER INTERFACE CHARACTERISTICS

Parameter		Symbol	Test Condition	Value			Unit	Note	
				Min.	Typ.	Max.			
On/Off Control Voltage	ON	VBLON	—	2.0	—	5.0	V		
	OFF		—	0	—	0.8	V		
External PWM Control Voltage	HI	VEPWM	—	2.0	—	5.25	V	Duty on	(5), (6)
	LO		—	0	—	0.8	V	Duty off	
External PWM Frequency		F _{EPWM}	—	150	160	170	Hz	Normal mode	
Error Signal		ERR	—	—	—	—	—	Abnormal: Open collector Normal: GND (4)	
VBL Rising Time		Tr1	—	30	—	—	ms	10%-90%V _{BL}	
Control Signal Rising Time		Tr	—	—	—	100	ms		
Control Signal Falling Time		Tf	—	—	—	100	ms		
PWM Signal Rising Time		TPWMR	—	—	—	50	us	(6)	
PWM Signal Falling Time		TPWMF	—	—	—	50	us		
Input Impedance		Rin	—	1	—	—	MΩ	EPWM, BLON	
PWM Delay Time		TPWM	—	100	—	—	ms	(6)	
BLON Delay Time	T _{on}		—	300	—	—	ms		
	T _{on1}		—	300	—	—	ms		
BLON Off Time		Toff	—	300	—	—	ms		

Note (1) The Dimming signal should be valid before backlight turns on by BLON signal. It is inhibited to change the external PWM signal during backlight turn on period.

Note (2) The power sequence and control signal timing are shown in the Fig.1. For a certain reason, the converter has a possibility to be damaged with wrong power sequence and control signal timing.

Note (3) While system is turned ON or OFF, the power sequences must follow as below descriptions:

Turn ON sequence: VBL → PWM signal → BLON

Turn OFF sequence: BLOFF → PWM signal → VBL

Note (4) When converter protective function is triggered, ERR will output open collector status.

Note (5) The EPWM interface that inserts a pull up resistor to 5V in Max Duty (100%), please refers to Fig.2.

Note (6) EPWM is available only at 2D Mode.

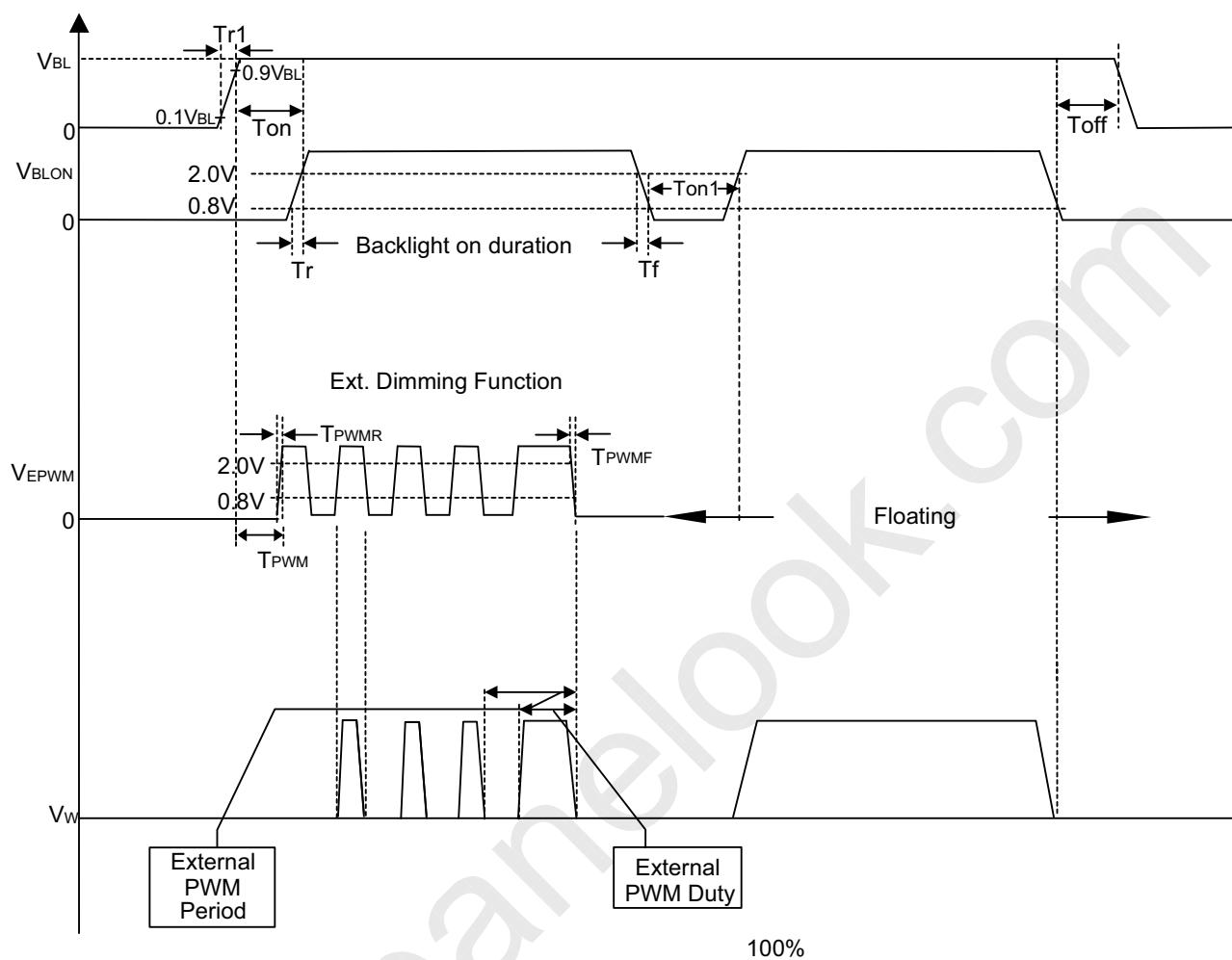


Fig. 1

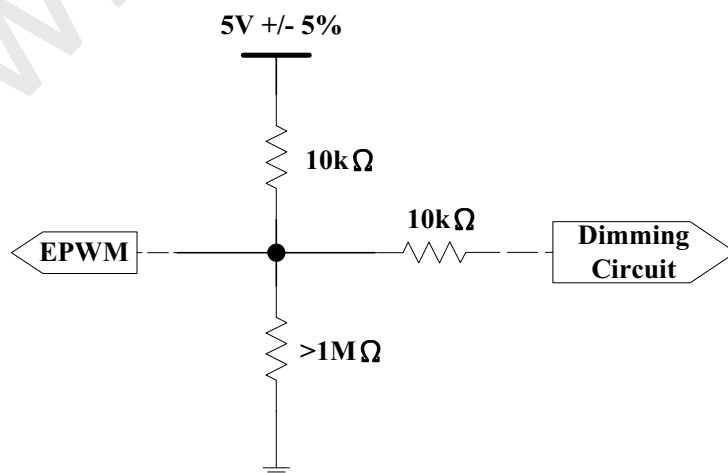
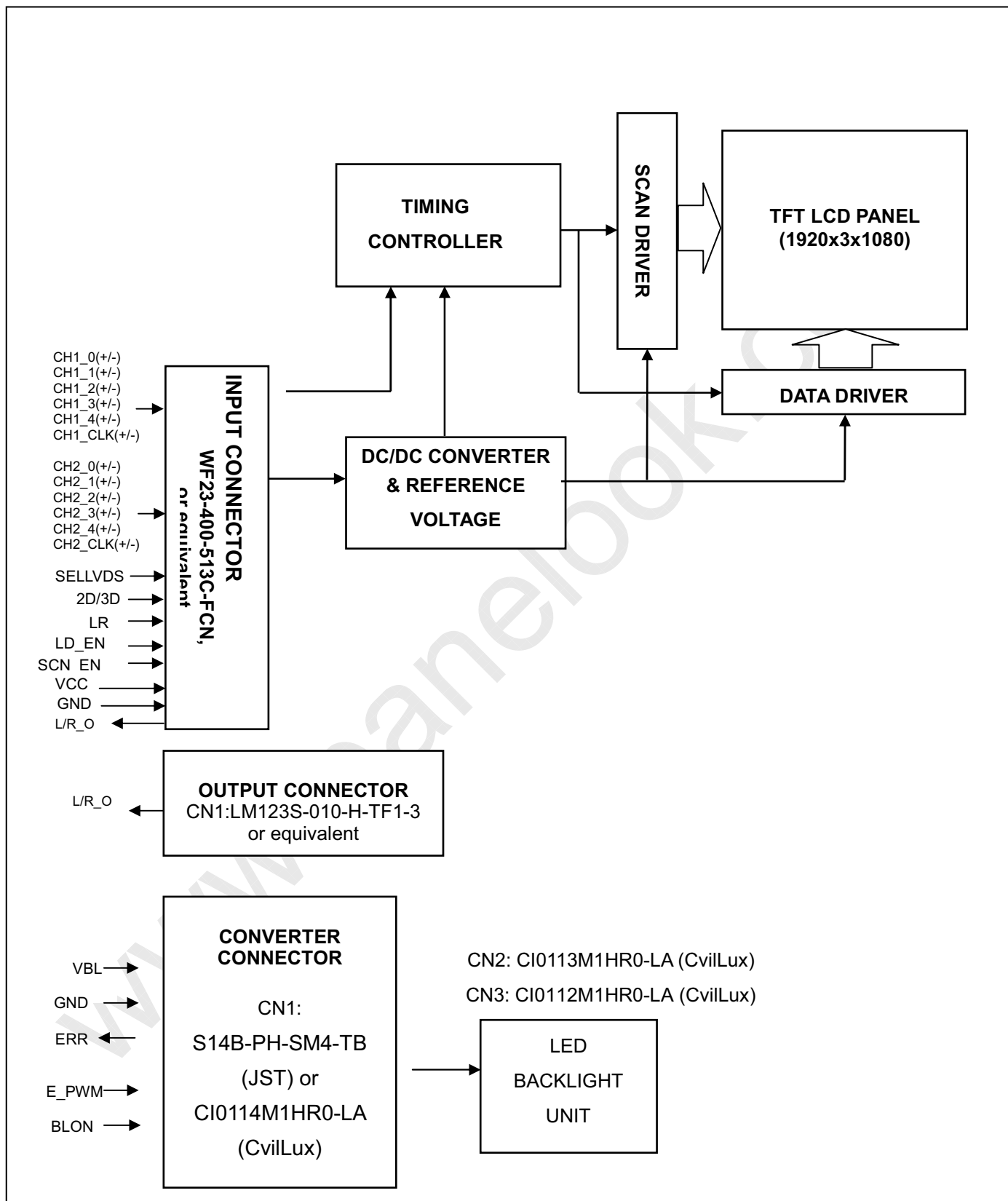


Fig. 2

4. BLOCK DIAGRAM OF INTERFACE

4.1 TFT LCD MODULE



5 .INPUT TERMINAL PIN ASSIGNMENT

5.1 TFT LCD MODULE

CNF1 Connector Pin Assignment: **(WF23-400-513C-FCN)** or equivalent)

Pin	Name	Description	Note
1	N.C.	No Connection	(1)
2	SCL	I2C Serial Clock (for 3D format selection function)	(11)
3	SDA	I2C Serial Data (for 3D format selection function)	
4	N.C.	No Connection	(1)
5	L/R_O	Output signal for Left Right Glasses control	(10)
6	N.C.	No Connection	(1)
7	SELLVDS	Input signal for LVDS Data Format Selection	(2)(7)
8	N.C.	No Connection	(1)
9	N.C.	No Connection	
10	N.C.	No Connection	
11	GND	Ground	
12	ORX0-	Odd pixel Negative LVDS differential data input. Channel 0	(9)
13	ORX0+	Odd pixel Positive LVDS differential data input. Channel 0	
14	ORX1-	Odd pixel Negative LVDS differential data input. Channel 1	
15	ORX1+	Odd pixel Positive LVDS differential data input. Channel 1	
16	ORX2-	Odd pixel Negative LVDS differential data input. Channel 2	
17	ORX2+	Odd pixel Positive LVDS differential data input. Channel 2	
18	GND	Ground	
19	OCLK-	Odd pixel Negative LVDS differential clock input	(9)
20	OCLK+	Odd pixel Positive LVDS differential clock input	
21	GND	Ground	
22	ORX3-	Odd pixel Negative LVDS differential data input. Channel 3	(9)
23	ORX3+	Odd pixel Positive LVDS differential data input. Channel 3	
24	N.C.	No Connection	
25	N.C.	No Connection	
26	2D/3D	Input signal for 2D/3D Mode Selection	(3)(6)(8)
27	L/R	Input signal for Left Right eye frame synchronous(Frame sequence mode)	(4)(8)



28	ERX0-	Even pixel Negative LVDS differential data input. Channel 0	(9)
29	ERX0+	Even pixel Positive LVDS differential data input. Channel 0	
30	ERX1-	Even pixel Negative LVDS differential data input. Channel 1	
31	ERX1+	Even pixel Positive LVDS differential data input. Channel 1	
32	ERX2-	Even pixel Negative LVDS differential data input. Channel 2	
33	ERX2+	Even pixel Positive LVDS differential data input. Channel 2	
34	GND	Ground	
35	ECLK-	Even pixel Negative LVDS differential clock input.	(9)
36	ECLK+	Even pixel Positive LVDS differential clock input.	
37	GND	Ground	
38	ERX3-	Even pixel Negative LVDS differential data input. Channel 3	(9)
39	ERX3+	Even pixel Positive LVDS differential data input. Channel 3	
40	N.C.	No Connection	
41	N.C.	No Connection	
42	LD_EN	Input signal for Local Dimming Enable	(5)(8)
43	SCN_EN	Input signal for Scanning Enable	(6)(8)
44	GND	Ground	
45	GND	Ground	
46	GND	Ground	
47	N.C.	No Connection	
48	VCC	+12V power supply	
49	VCC	+12V power supply	
50	VCC	+12V power supply	
51	VCC	+12V power supply	

CN1 Connector Pin Assignment (LM123S-010-H-TF1-3 (UNE) or equivalent)

1	N.C.	No Connection	(1)
2	N.C.	No Connection	
3	N.C.	No Connection	
4	GND	Ground	
5	N.C.	No Connection	(1)
6	L/R_O	Output signal for Left Right Glasses control	(10)
7	N.C.	No Connection	(1)
8	N.C.	No Connection	
9	N.C.	No Connection	
10	N.C.	No Connection	

Note (1) Reserved for internal use. Please leave it open.

Note (2) LVDS format selection.

L= Connect to GND, H=Connect to +3.3V or Open

SELLVDS	Note
L	JEIDA Format
H or Open	VESA Format

Note (3) 2D/3D mode selection.

L= Connect to GND or Open, H=Connect to +3.3V

2D/3D	Note
L or Open	2D Mode
H	3D Mode

Note (4) Input signal for Left Right eye frame synchronous

$V_{IL}=0\sim 0.8\text{ V}$, $V_{IH}=2.0\sim 3.3\text{ V}$

L/R	Note
L	Right synchronous signal
H	Left synchronous signal

Note (5) Local dimming enable selection.

L= Connect to GND, H=Connect to +3.3V or Open

LD_EN	Note
L	Local Dimming Disable
H or Open	Local Dimming Enable

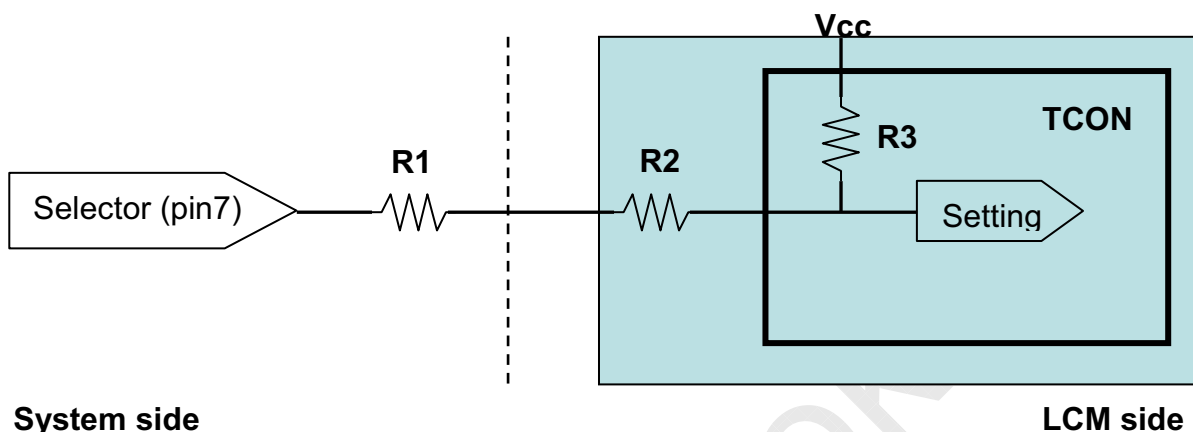
Note (6) Scanning enable selection.

L= Connect to GND or Open, H=Connect to +3.3V

SCN_EN	Note
L or Open	Scanning Disable
H	Scanning Enable

Note (7) SELLVDS LD_EN signal pin connected to the LCM side has the following diagram.

R1 in the system side should be less than 1K Ohm. ($R1 < 1K\ \Omega$)

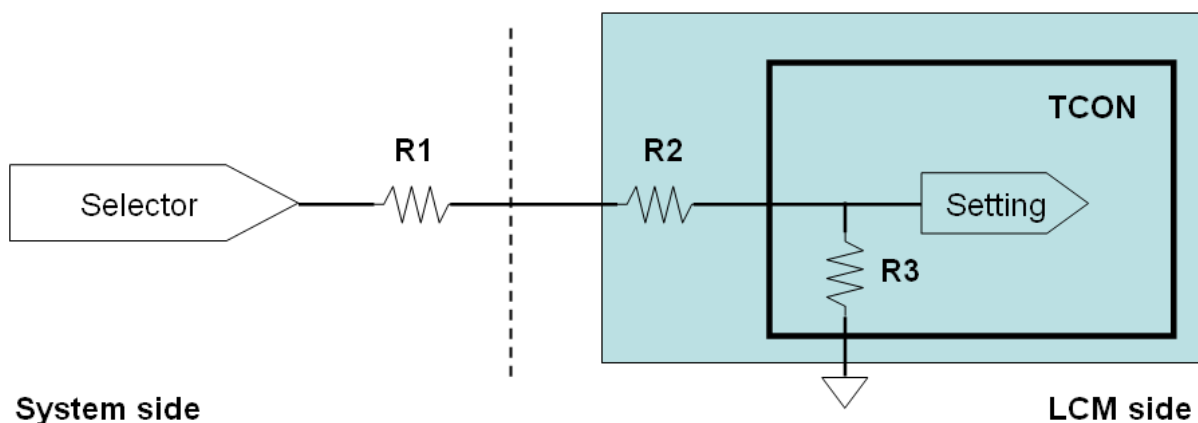


System side

$R1 < 1K$

Note (8) 2D/3D, L/R and SCN_EN signal pin connected to the LCM side has the following diagram.

R1 in the system side should be less than 1K Ohm. ($R1 < 1K\ \Omega$)



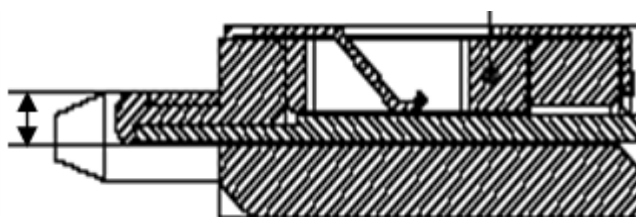
System side: $R1 < 1K$

Note (9) Two pixel data send into the module for every clock cycle. The first pixel of the frame is odd pixel and the second pixel is even pixel.

Note (10) The definition of L/R_O signal as follows

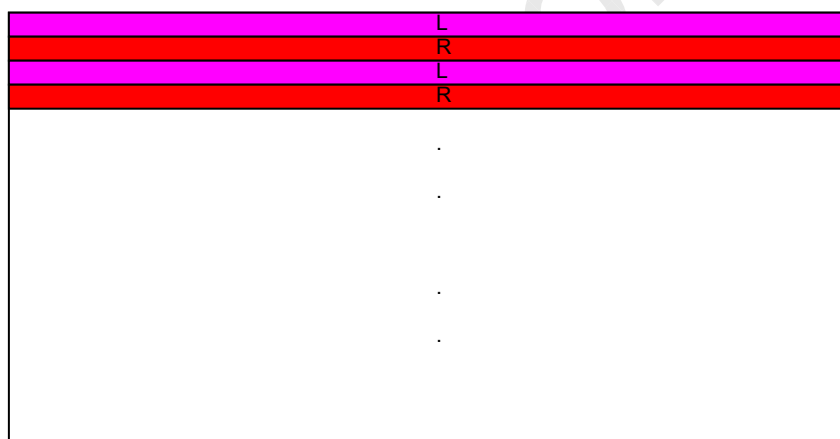
L= 0V , H= +3.3V

L/R_O	Note
L	Right glass turn on
H	Left glass turn on



Note (11) Please reference Appendix A

Note (12) Currently, we only support line alternative format (1st line is left signal), show as the attached block diagram. In the future, we will support other format.



Line alternative format

5.2 BACKLIGHT UNIT

The pin configuration for the housing and leader wire is shown in the table below.

CN2,3,6,7: 196388-12041-3 (P-TWO)

Pin №	Symbol	Feature
1	VLED	Positive of LED String
2	VLED	
3	VLED	
4	VLED	
5	NC	NC
6	NC	
7	NC	
8	NC	
9	N1	Negative of LED String
10	N2	
11	N3	
12	N4	

Note (1)The backlight interface housing for high voltage side is a model 51281-1094, manufactured by Molex or equivalent. The mating header on converter part number is 51281-1094

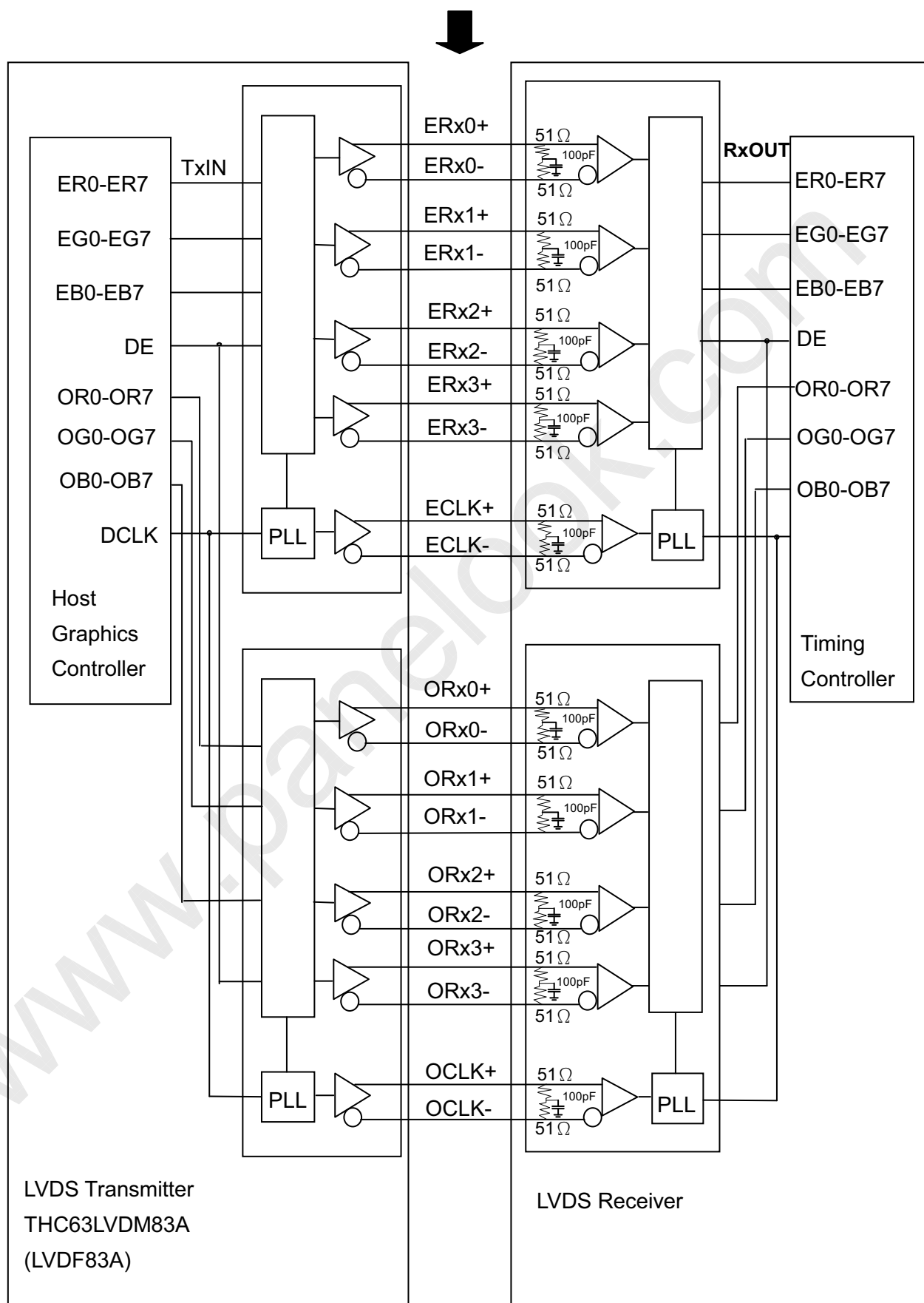
5.3 DRIVING BOARD UNIT

CN1(Header): S14B-PH-SM4-TB (JST) or CI0114M1HR0-LA (CviiLux)

Pin No.	Symbol	Feature
1	VBL	+24V
2		
3		
4		
5	GND	GND
6		
7		
8		
9	ERR	Normal (GND) Abnormal (Open)
10		BL ON/OFF
11	BLON	NC
12	NC	NC
13	E_PWM	External PWM Control
14		

Notice

1. If Pin14 is open, E_PWM is 100% duty.

5.4 BLOCK DIAGRAM OF INTERFACE


ER0~ER7: Even pixel R data

EG0~EG7: Even pixel G data

EB0~EB7: Even pixel B data

OR0~OR7: Odd pixel R data

OG0~OG7: Odd pixel G data

OB0~OB7: Odd pixel B data

DE: Data enable signal

DCLK: Data clock signal

Note (1) The system must have the transmitter to drive the module.

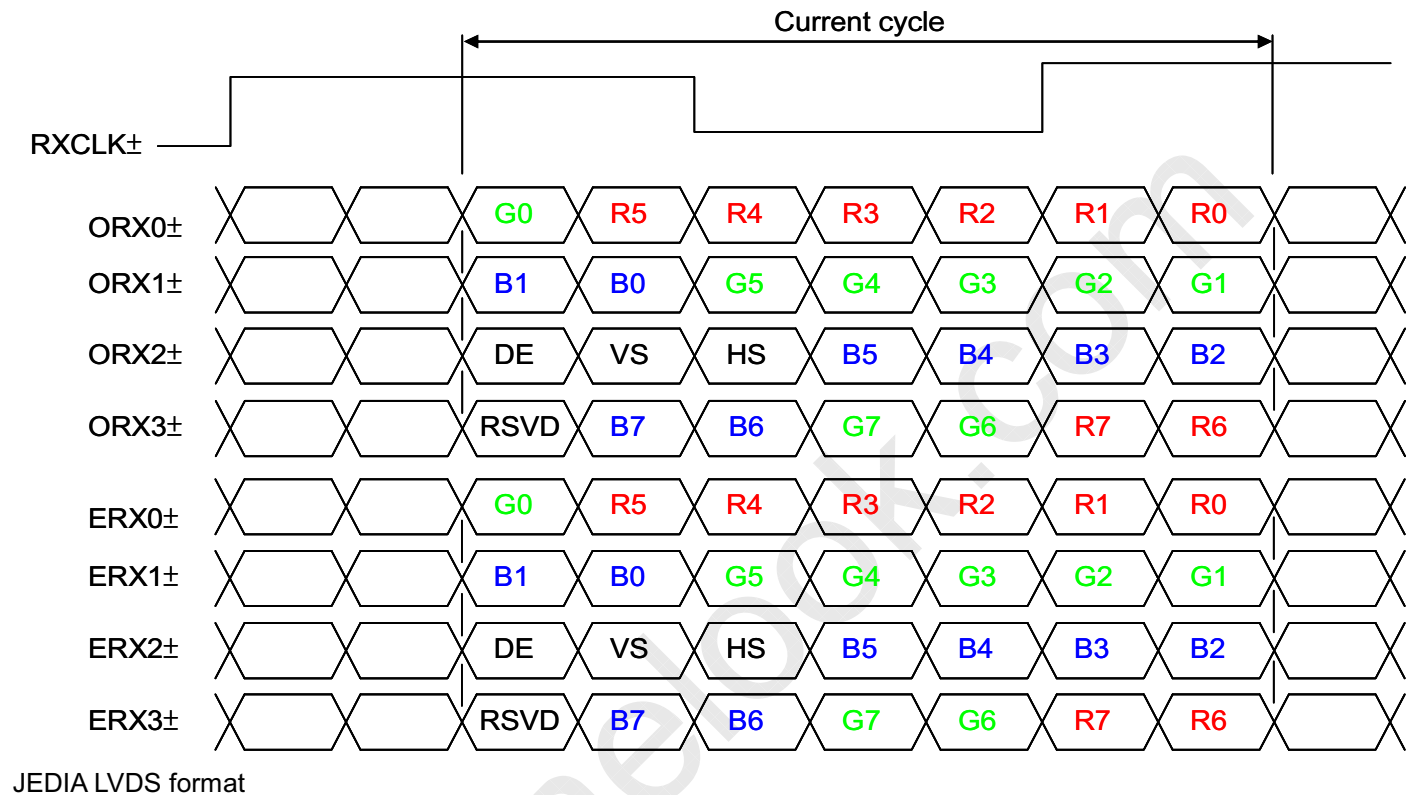
Note (2) LVDS cable impedance shall be 50 ohms per signal line or about 100 ohms per twist-pair line when it is used differentially.

5.5 LVDS INTERFACE

JEIDA Format : SELLVDS = L

VESA Format : SELLVDS = H or Open

VESA LVDS format



5.6 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of the color versus data input.

Color		Data Signal																							
		Red								Green								Blue							
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red (253)	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale Of Green	Green (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	Green (2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green (253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green (254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green (255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Gray Scale Of Blue	Blue (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue (2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue (253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
	Blue (254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue (255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1



Note (1) 0: Low Level Voltage, 1: High Level Voltage

www.panelook.com

6. INTERFACE TIMING

6.1 INPUT SIGNAL TIMING SPECIFICATIONS ($T_a = 25 \pm 2^\circ\text{C}$)

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
LVDS Receiver Clock	Frequency	F_{clkin} ($=1/TC$)	60	74.25	80	MHz	
	Input cycle to cycle jitter	T_{rcl}	-	-	200	ps	(3)
	Spread spectrum modulation range	$F_{\text{clkin_mod}}$	$F_{\text{clkin}}-2\%$	-	$F_{\text{clkin}}+2\%$	MHz	(4)
	Spread spectrum modulation frequency	F_{SSM}	-	-	200	KHz	
LVDS Receiver Data	Receiver Skew Margin	T_{RSKM}	-400	-	400	ps	(5)

6.1.1 Timing spec for Frame Rate = 50Hz

Signal	Item		Symbol	Min.	Typ.	Max.	Unit	Note
Frame rate	2D mode		F_{r5}	47	50	53	Hz	
	3D mode		F_{r5}	50	50	50	Hz	(7)
Vertical Active Display Term	2D Mode	Total	T_v	1115	1125	1380	Th	$T_v = T_{vd} + T_{vb}$
		Display	T_{vd}	1080	1080	1080	Th	—
		Blank	T_{vb}	35	45	300	Th	—
	3D Mdoe	Total	T_v	1350			Th	(6), (8)
		Display	T_{vd}	1080			Th	
		Blank	T_{vb}	270			Th	
Horizontal Active Display Term	2D Mode	Total	T_h	1050	1100	1150	T_c	$T_h = T_{hd} + T_{hb}$
		Display	T_{hd}	960	960	960	T_c	—
		Blank	T_{hb}	90	140	190	T_c	—
	3D Mdoe	Total	T_h	1050	1100	1150	T_c	$T_h = T_{hd} + T_{hb}$
		Display	T_{hd}	960	960	960	T_c	—
		Blank	T_{hb}	90	140	190	T_c	—

6.1.2 Timing spec for Frame Rate = 60Hz



Signal	Item		Symbol	Min.	Typ.	Max.	Unit	Note
Frame rate	2D mode		F _{r6}	57	60	62.5	Hz	
	3D mode		F _{r6}	60	60	60	Hz	(7)
Vertical Active Display Term	2D Mode	Total	Tv	1115	1125	1380	Th	Tv=Tvd+Tvb
		Display	Tvd	1080	1080	1080	Th	—
		Blank	Tvb	35	45	300	Th	—
	3D Mdoe	Total	Tv	1125			Th	(6), (8)
		Display	Tvd	1080			Th	
		Blank	Tvb	45			Th	
Horizontal Active Display Term	2D Mode	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
		Display	Thd	960	960	960	Tc	—
		Blank	Thb	90	140	190	Tc	—
	3D Mdoe	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
		Display	Thd	960	960	960	Tc	—
		Blank	Thb	90	140	190	Tc	—

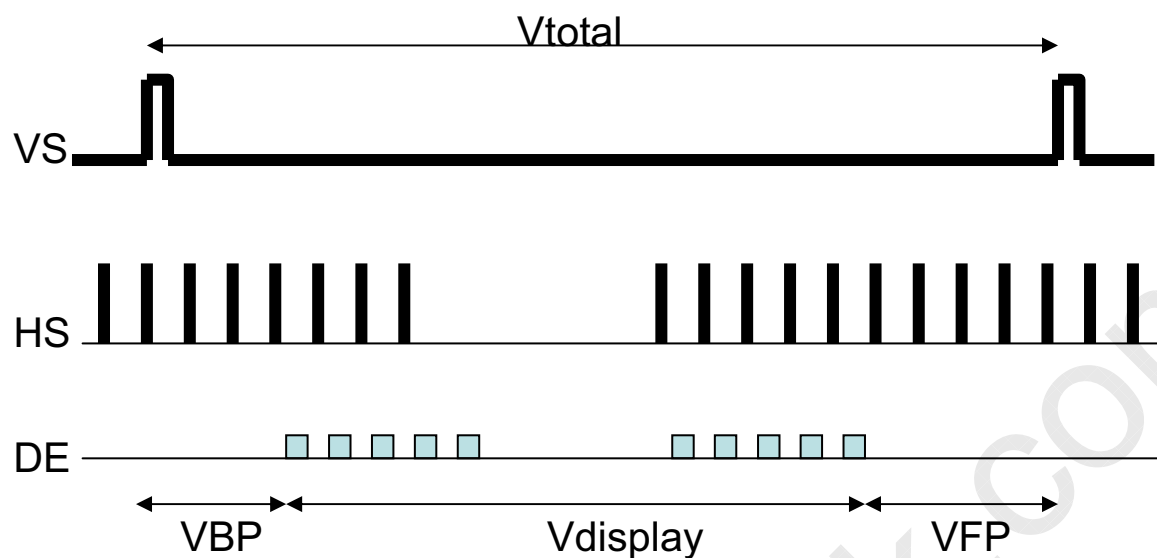
Note (1) Since the module is operated in DE only mode, Hsync and Vsync input signals should be set to low logic level. Otherwise, this module would operate abnormally.

Note (2) Please make sure the range of pixel clock has follow the below equation:

$$F_{clk}(max) \geq F_{r6} \times Tv \times Th$$

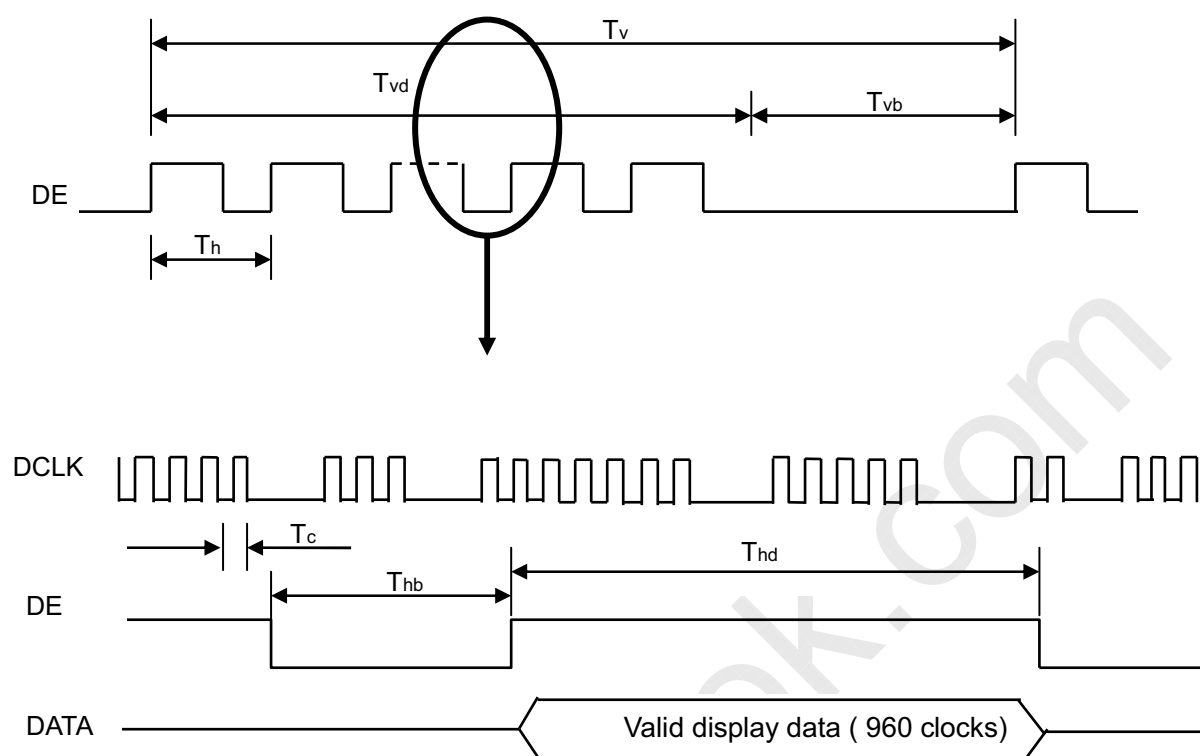
$$F_{r5} \times Tv \times Th \geq F_{clk}(min)$$

INPUT SIGNAL TIMING DIAGRAM

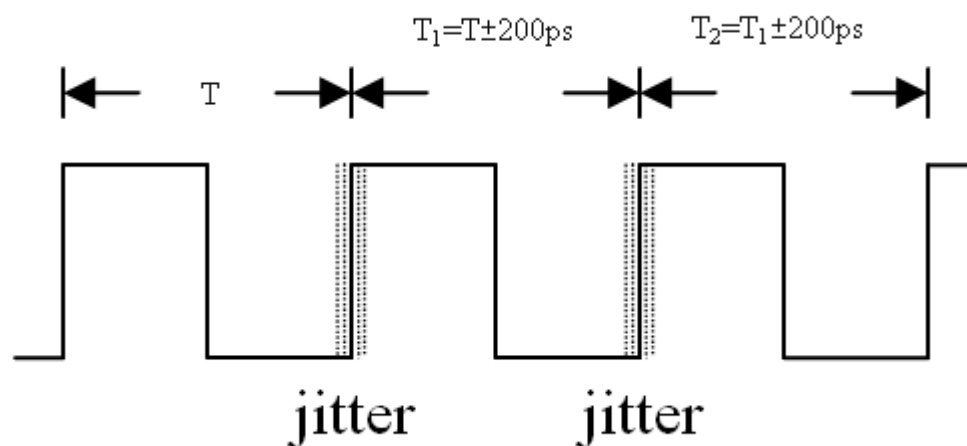


- VBP max : 150 line

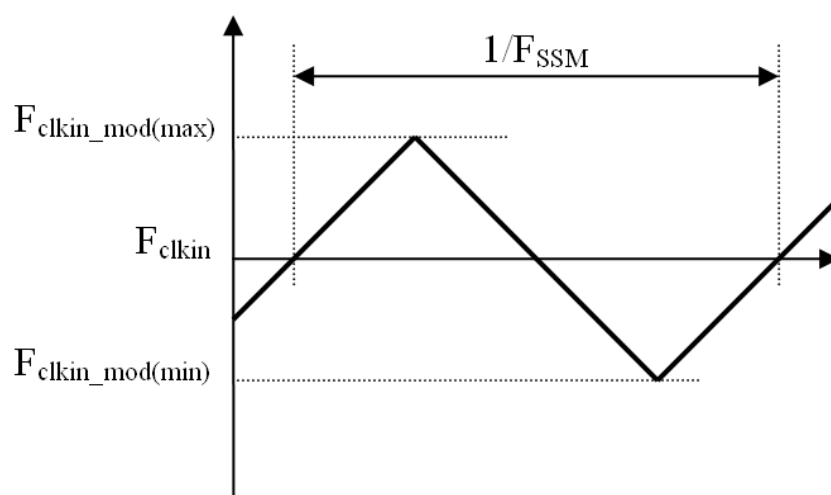
Suggest $VBP = VFP = \frac{1}{2} * (V_{total} - V_{display})$



Note (3) The input clock cycle-to-cycle jitter is defined as below figures. $Trcl = |T_1 - T|$

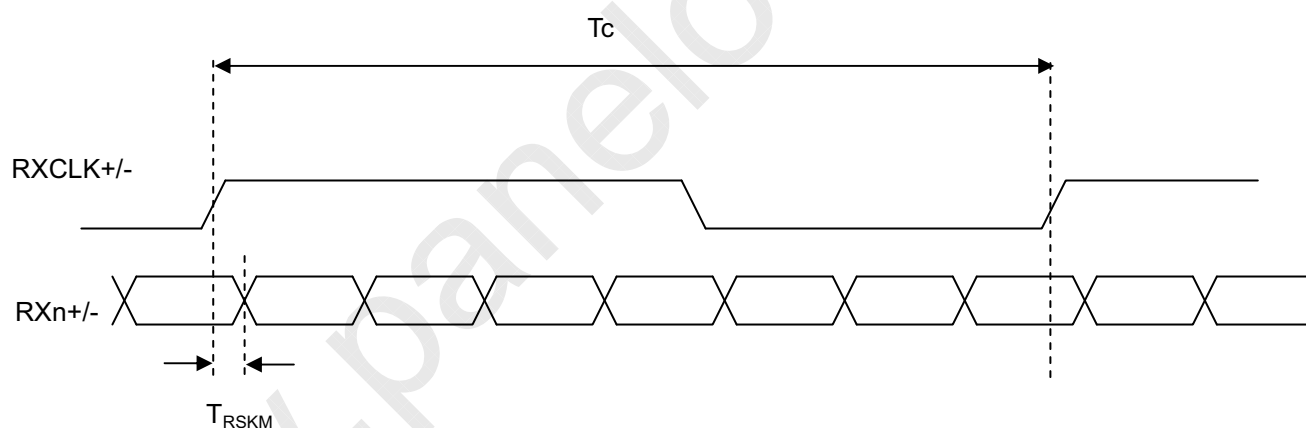


Note (4) The SSCG (Spread spectrum clock generator) is defined as below figures.



Note (5) LVDS receiver skew margin is defined and shown as below.

LVDS RECEIVER INTERFACE TIMING DIAGRAM



Note (6) Please fix the Vertical timing (Vertical Total =1350 / Display =1080 / Blank = 270) in 100Hz 3D mode
and Vertical timing (Vertical Total =1125 / Display =1080 / Blank = 45) in 120Hz 3D mode

Note (7) In 3D mode, the set up Fr5 and Fr6 in Typ. ± 3 Hz .In order to ensure that the electric function performance to avoid no display symptom.(Except picture quality symptom.)

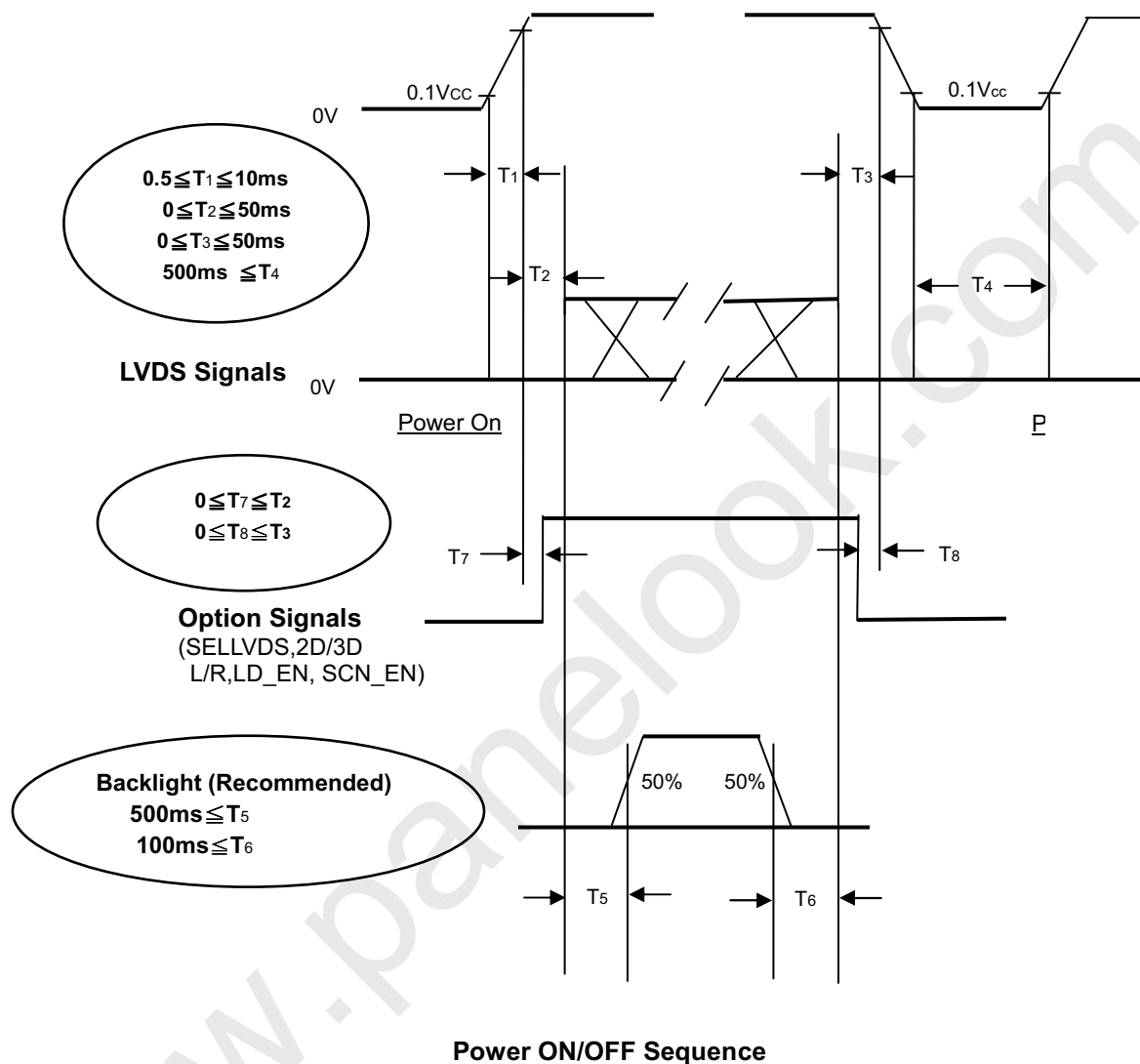
Note (8) In 3D mode, the set up Tv and Tvb in Typ. ± 30 .In order to ensure that the electric function performance to avoid no display symptom.(Except picture quality symptom.)

6.2 POWER ON/OFF SEQUENCE

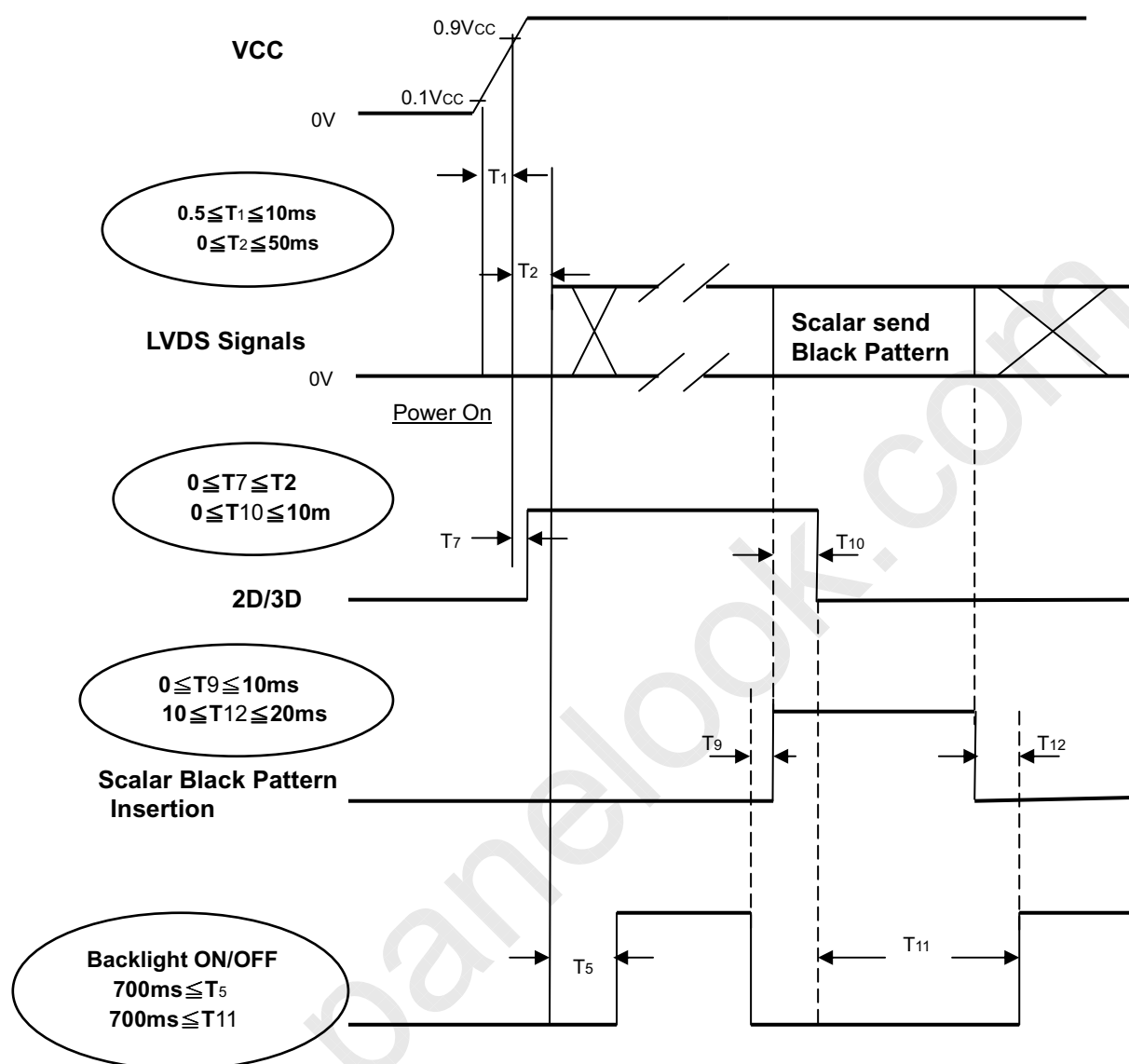
(Ta = 25 ± 2 °C)

6.2.1 POWER ON/OFF SEQUENCE

To prevent a latch-up or DC operation of LCD module, the power on/off sequence should be as the diagram below.



6.2.2 2D/3D MODE CHANGE SIGNAL SEQUENCE WITHOUT VCC TURN OFF AND TURN ON



Note (1) The supply voltage of the external system for the module input should follow the definition of V_{cc}.

Note (2) Apply the LED voltage within the LCD operation range. When the backlight turns on before the LCD operation or the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen.

Note (3) In case of V_{cc} is in off level, please keep the level of input signals on the low or high impedance. If T₂<0, that maybe cause electrical overstress failure.

Note (4) T₄ should be measured after the module has been fully discharged between power off and on period.

Note (5) Interface signal shall not be kept at high impedance when the power is on.

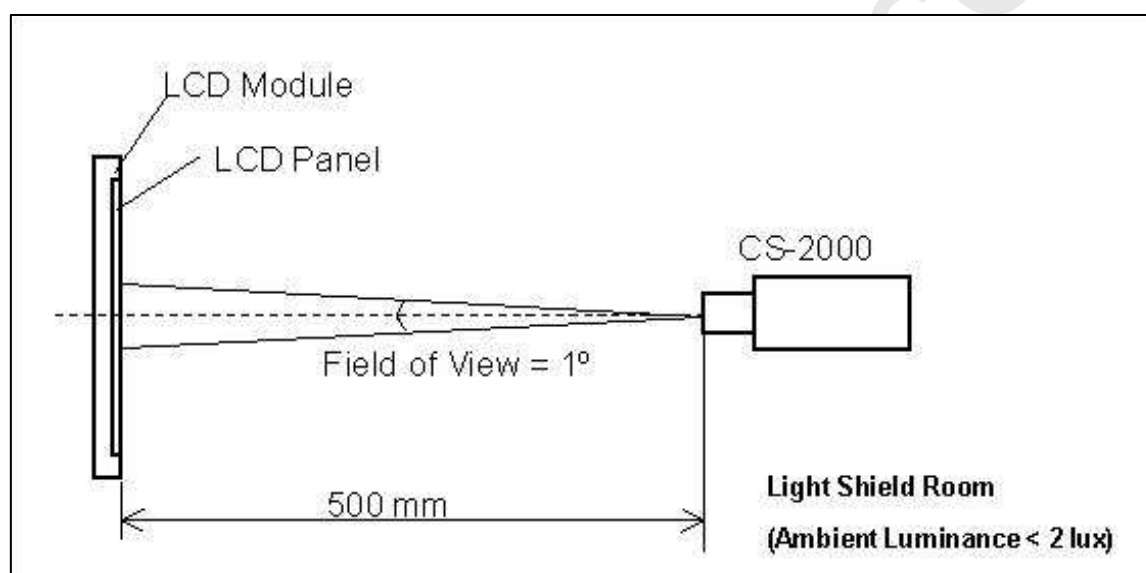
Note (6) When 2D/3D mode is changed, TCON will insert black pattern internally. During black insertion, TCON would load required optical table and TCON parameter setting. The black insertion time should be longer than 650ms because TCON must recognize 2D or 3D format and set the correct parameter.

7. OPTICAL CHARACTERISTICS**7.1 TEST CONDITIONS**

Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	°C
Ambient Humidity	Ha	50±10	%RH
Supply Voltage	V _{CC}	12±1.2	V
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"		
LED Current	I _L	115±3.45	mA

The LCD module should be stabilized at given temperature for 1 hour to avoid abrupt temperature change during measuring in a windless room.

Local Dimming Function should be Disable before testing to get the steady optical characteristics (According to 5.1 CNF1 Connector Pin Assignment, Pin no. "42")





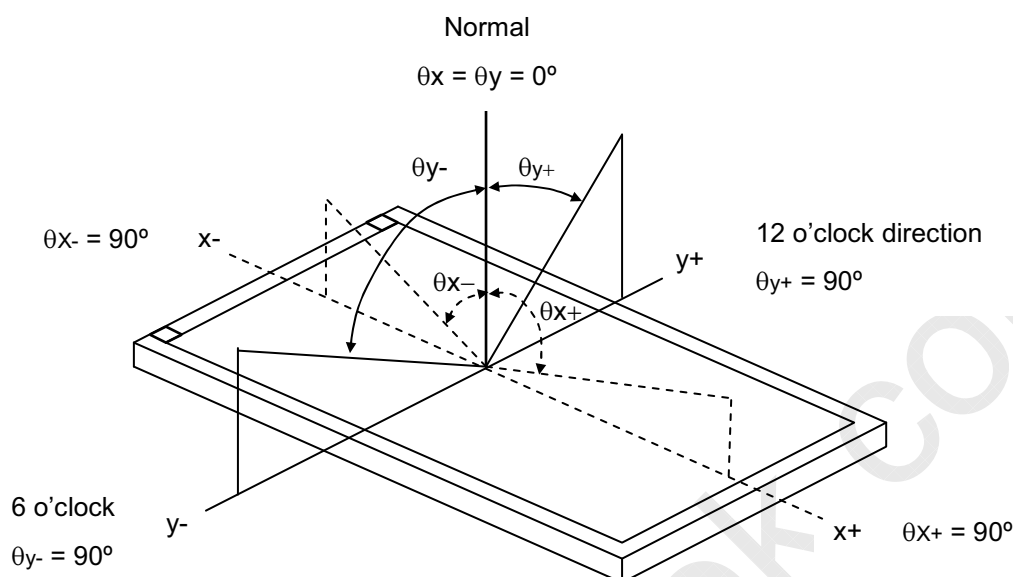
7.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 7.2. The following items should be measured under the test conditions described in 7.1 and stable environment shown in 7.1.

Item		Symbol		Condition	Min.	Typ.	Max.	Unit	Note	
Contrast Ratio		CR		$\theta_x=0^\circ, \theta_Y=0^\circ$ Viewing angle at normal direction	3500	5000	-	-	Note (2)	
Response Time		Gray to gray				6.5	13	ms	Note (3)	
Center Luminance of White	L_c	2D			320	400	-	cd/m ²	Note (4)	
		3D				100	-	cd/m ²	Note (8)	
White Variation		δW					1.3	-	Note (6)	
Cross Talk	CT	2D			-		4	%	Note (5)	
		3D-W				4	-	%	Note (8)	
		3D-D				11	-	%	Note (8)	
Color Chromaticity	Red	Rx			Typ.- 0.03	0.644	Typ.+ 0.03 9800	-		
		Ry						-		
	Green	Gx		0.330				-		
		Gy		0.296				-		
	Blue	Bx		0.595				-		
		By		0.148				-		
	White	Wx		0.054				-		
		Wy		0.280				-		
	Correlated color temperature							0.290		-
								9800		K
Viewing Angle	Horizontal	θ_x+		CR $\geq$ 20	80	88	-	Deg.	(1)	
		θ_x-			80	88	-			
	Vertical	θ_Y+			80	88	-			
		θ_Y-			80	88	-			
Transmission direction of the up polarizer		Φ_{up}		-	-	90	-	Deg.	(7)	
slow axis of the QWP		Φ_{up-Q}		-	-	135	-	Deg.	(7)	

Note (1) Definition of Viewing Angle (θ_x , θ_y):

Viewing angles are measured by Autronic Conoscope Cono-80.



Note (2) Definition of Contrast Ratio (CR) :

The contrast ratio can be calculated by the following expression.

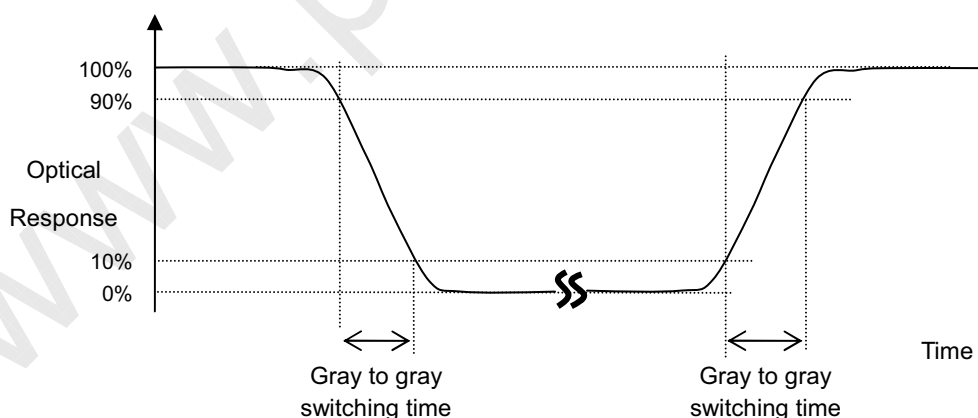
$$\text{Contrast Ratio (CR)} = \frac{\text{Surface Luminance of L1023}}{\text{Surface Luminance of L0}}$$

L1023: Luminance of gray level 1023

L 0: Luminance of gray level 0

$CR = CR(5)$, where $CR(X)$ is corresponding to the Contrast Ratio of the point X at the figure in Note (6).

Note (3) Definition of Gray-to-Gray Switching Time:



The driving signal means the signal of gray level 0, 124, 252, 380, 508, 636, 764, 892 and 1023.

Gray to gray average time means the average switching time of gray level 0, 124, 252, 380, 508, 636, 764, 892 and 1023 to each other.

Note (4) Definition of Luminance of White (L_C):

Measure the luminance of gray level 1023 at center point.

$L_C = L(5)$, where $L(x)$ is corresponding to the luminance of the point X at the figure in Note (6).

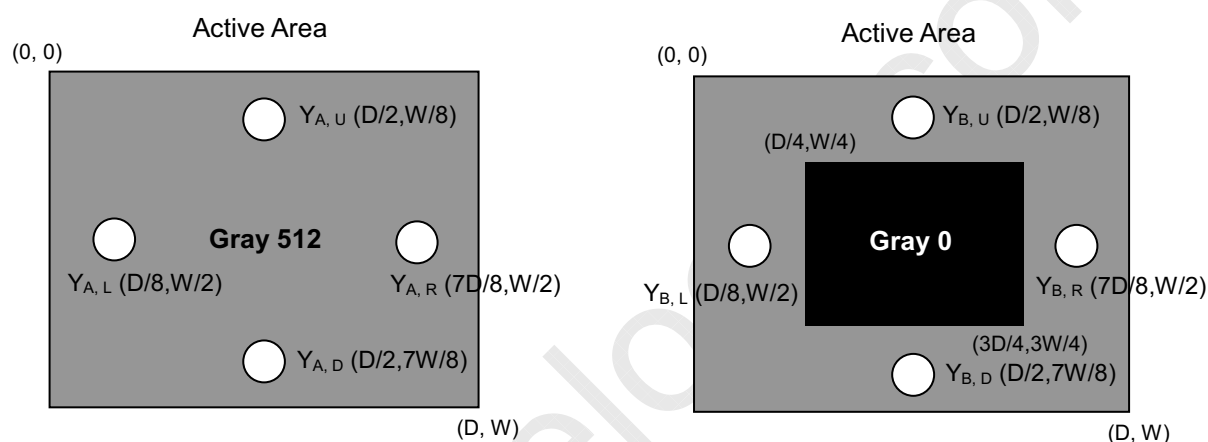
Note (5) Definition of Cross Talk (CT):

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where:

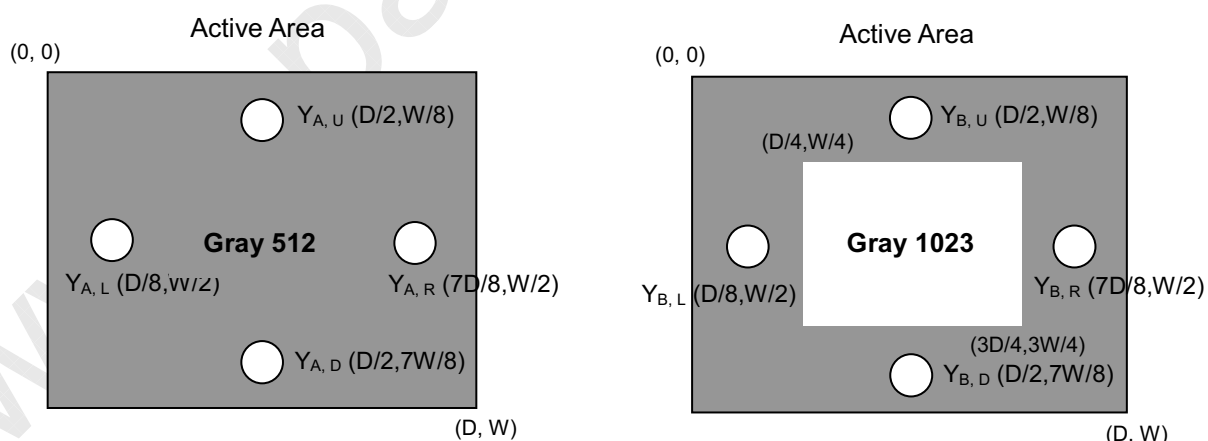
Y_A = Luminance of measured location without gray level 0 pattern (cd/m²)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m²)



Y_A = Luminance of measured location without gray level 1023 pattern (cd/m²)

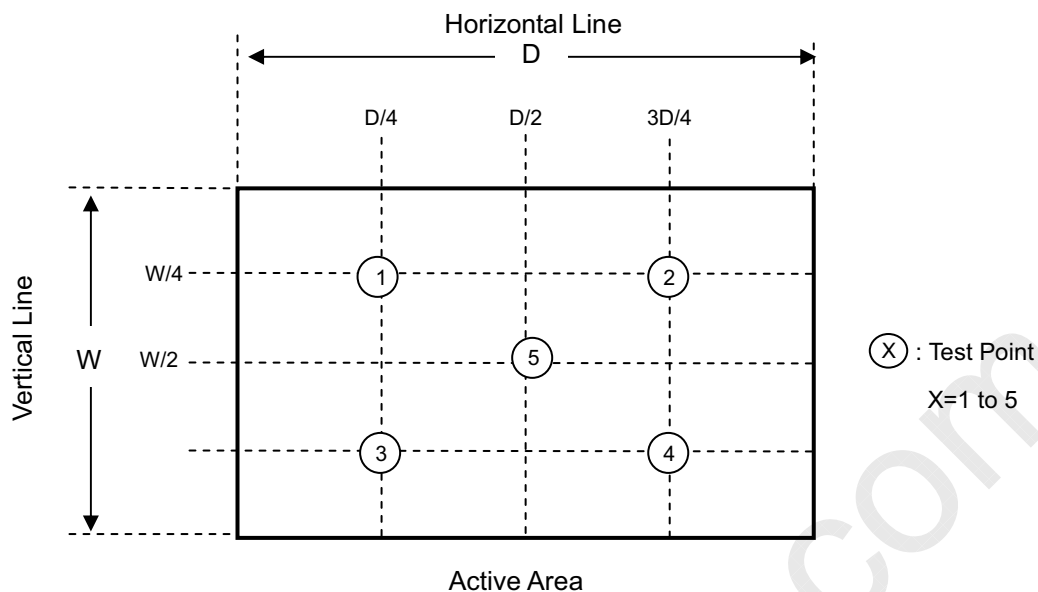
Y_B = Luminance of measured location with gray level 1023 pattern (cd/m²)



Note (6) Definition of White Variation (δW):

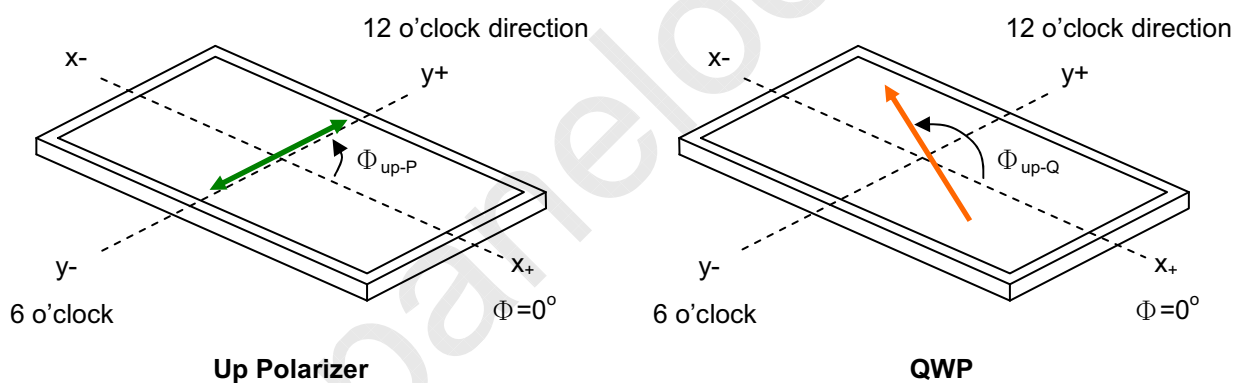
Measure the luminance of gray level 1023 at 5 points

$$\delta W = \text{Maximum} [L(1), L(2), L(3), L(4), L(5)] / \text{Minimum} [L(1), L(2), L(3), L(4), L(5)]$$

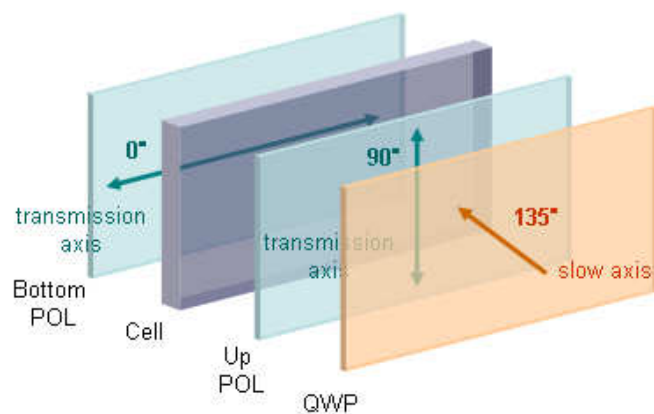
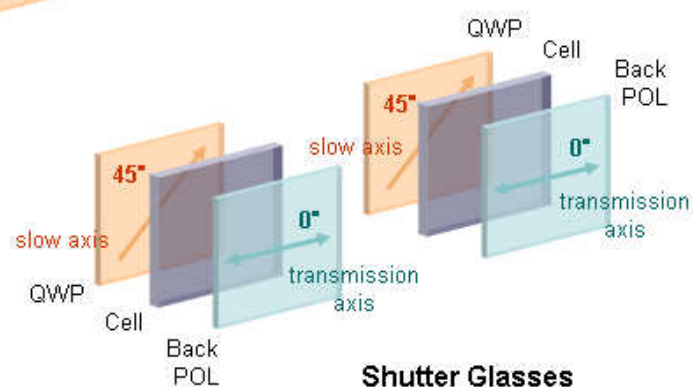


Note (7) This is a reference for designing the shutter glasses of 3D application. (VA case)

Definition of the transmission direction of the up polarizer (Φ_{up-P}) and the slow axis of QWP (Φ_{up-Q}) on LCD Module:



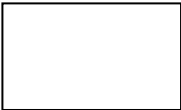
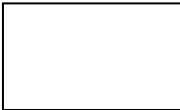
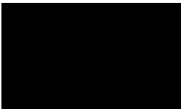
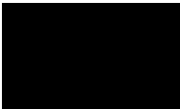
The slow axis of the QWP on shutter glasses should be perpendicular to the QWP on LCD Module to get better 3D performance.

**LCD Module****Shutter Glasses**

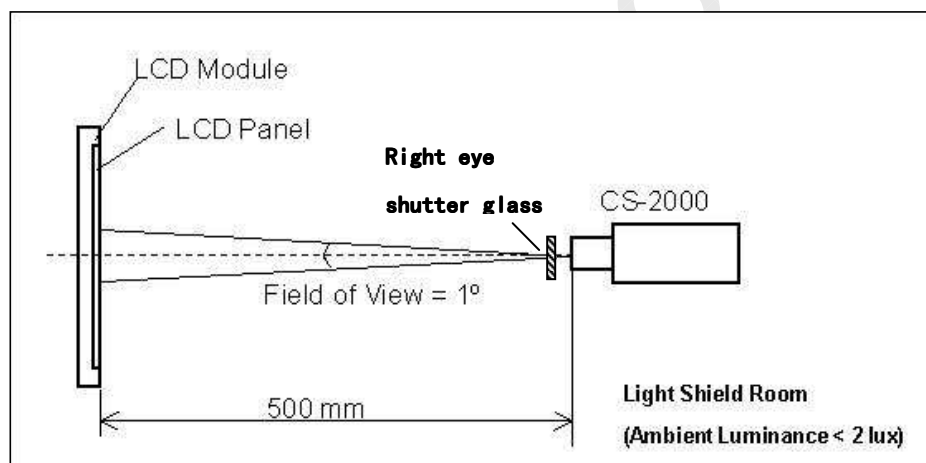
Note(8) Definition of the 3D mode performance (measured under 3D mode, use CMI' s shutter glass):

a. Test pattern

Left eye image and right eye image are displayed alternated

		WW Left eye image: W1023; Right eye image: W1023
		WB Left eye image: W1023; Right eye image: W0
		BW Left eye image: W0; Right eye image: W1023
		BB Left eye image: W0; Right eye image: W0

b. Measurement setup



Shutter glasses are well controlled under suitable timing, and measure the luminance of the center point of the panel through the right eye glass. The transmittance of the glass should be larger than 40.0% under 3D mode operation.

The luminance of the test pattern "WW", denoted $L(WW)$; the luminance of the test pattern "WB", denoted $L(WB)$; the luminance of the test pattern "BW", denoted $L(BW)$; the luminance of the test pattern "BB", denoted $L(BB)$

c. Definition of the Center Luminance of White, $L_c(3D) : L(WW)$

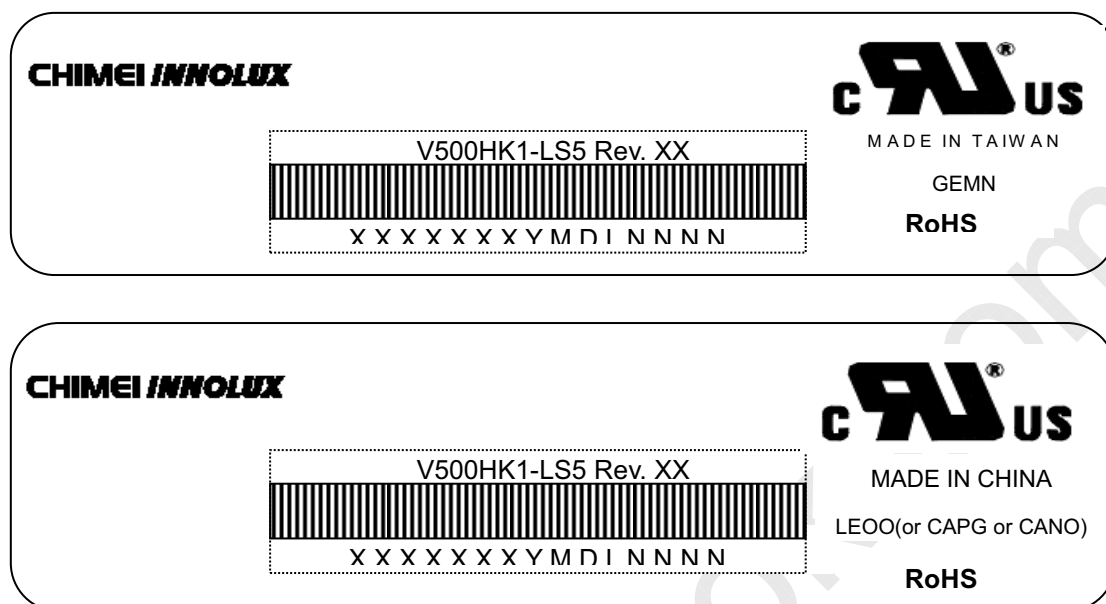
d. Definition of the 3D mode white crosstalk, $CT(3D-W) : CT(3D-W) \equiv \frac{L(WB) - L(BB)}{L(WW) - L(BB)}$

e. Definition of the 3D mode dark crosstalk, $CT(3D-D) : CT(3D-D) \equiv \frac{L(WW) - L(BW)}{L(WW) - L(BB)}$

8. DEFINITION OF LABELS

8.1 CMI MODULE LABEL

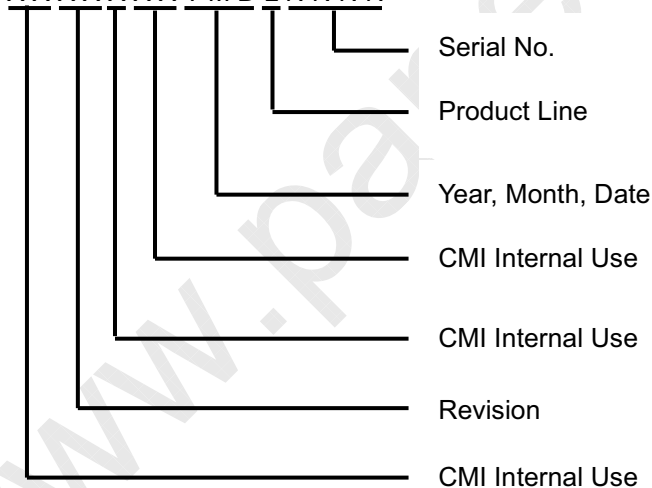
The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



Model Name: V500HK1-LS5

Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

Serial ID: XXXXXXYMDLNNNN



Serial ID includes the information as below:

Manufactured Date:

Year : 2001=1, 2002=2, 2003=3, 2004=4...2010=0, 2011=1, 2012=2...

Month: 1~9, A~C, for Jan. ~ Dec.

Day: 1~9, A~Y, for 1st to 31st, exclude I ,O, and U.

Revision Code : Cover all the change

Serial No. : Manufacturing sequence of product

Product Line : 1 → Line1, 2 → Line 2, ...etc.

9. Packaging

9.1 PACKING SPECIFICATIONS

- (1) 4 LCD TV modules / 1 Box
- (2) Box dimensions: 1235(L) X 258 (W) X 751 (H)
- (3) Weight: approximately 59.8 Kg (4 modules per box)

9.2 PACKING METHOD

Figures 9-1 and 9-2 are the packing method

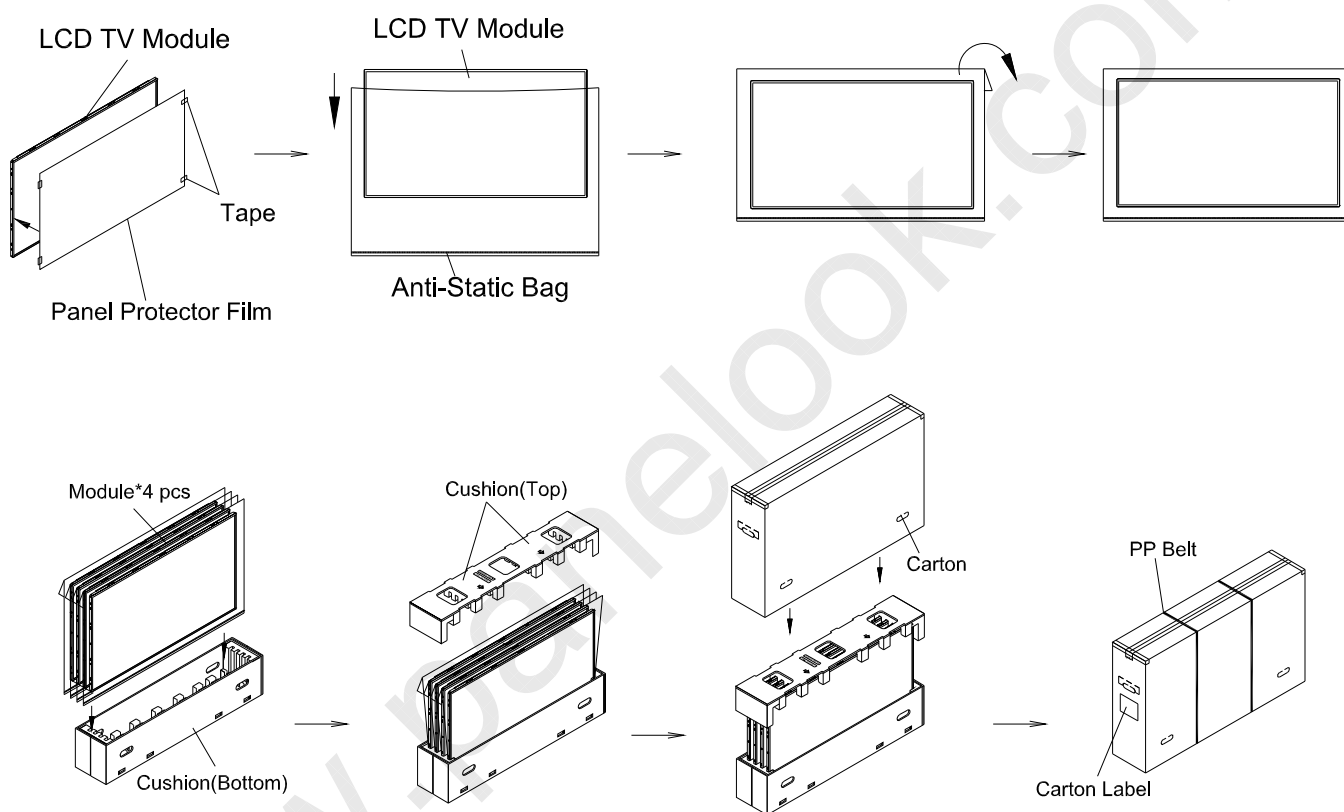
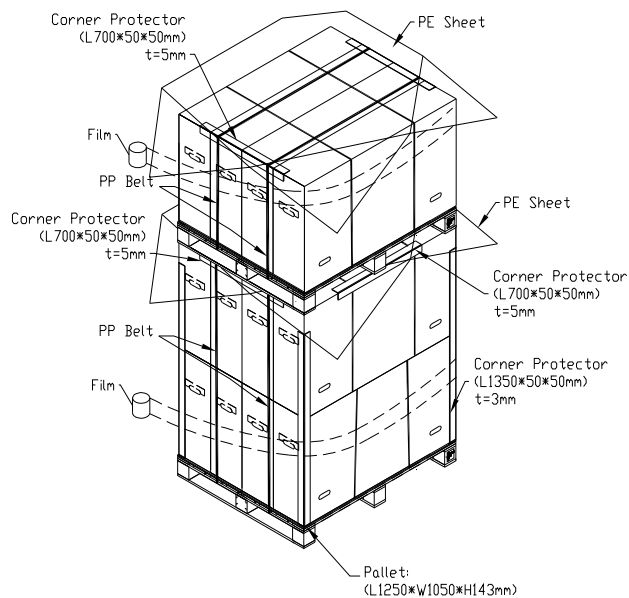


Figure.9-1 packing method

Sea / Land Transportation (40ft HQ Container)



Sea / Land Transportation (40ft/20ft Container)

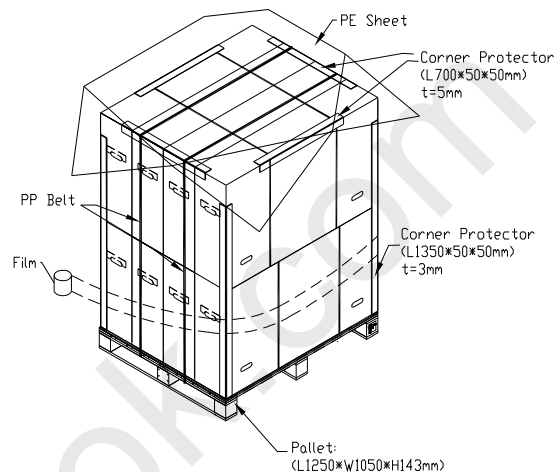


Figure. 9-2 Packing method

10. PRECAUTIONS

10.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) It is recommended to assemble or to install a module into the user's system in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) Do not apply pressure or impulse to the module to prevent the damage of LCD panel and backlight.
- (4) Always follow the correct power-on sequence when the LCD module is turned on. This can prevent the damage and latch-up of the CMOS LSI chips.
- (5) Do not plug in or pull out the I/F connector while the module is in operation.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) Moisture can easily penetrate into LCD module and may cause the damage during operation.
- (9) High temperature or humidity may deteriorate the performance of LCD module. Please store LCD modules in the specified storage conditions.
- (10) When ambient temperature is lower than 10°C, the display quality might be reduced. For example, the response time will become slow, and the starting voltage of LED will be higher than that of room temperature.

10.2 SAFETY PRECAUTIONS

- (1) The startup voltage of a backlight is over 1000 Volts. It may cause an electrical shock while assembling with the inverter. Do not disassemble the module or insert anything into the backlight unit.
- (2) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (3) After the module's end of life, it is not harmful in case of normal operation and storage.

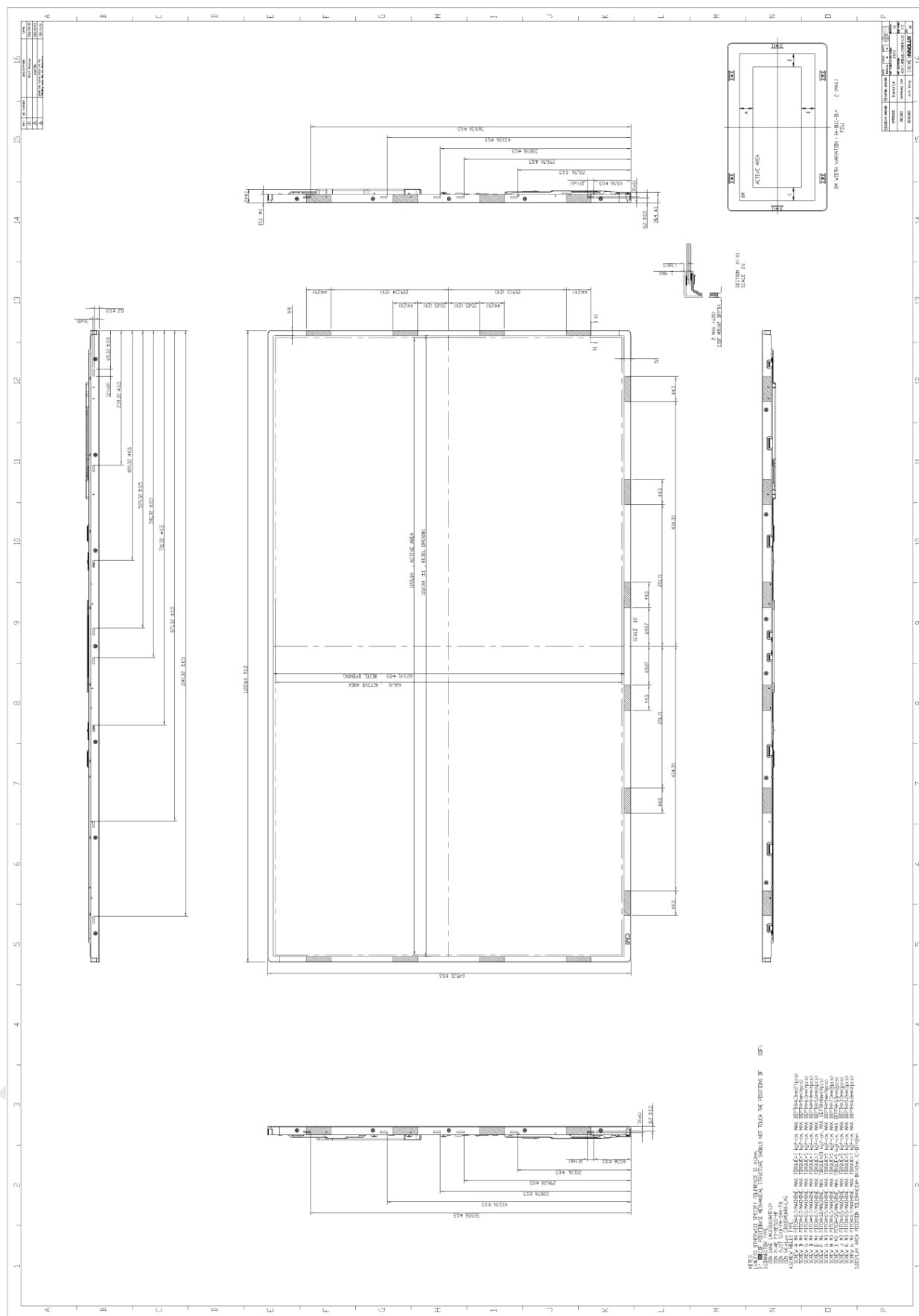
10.3 SAFETY STANDARDS

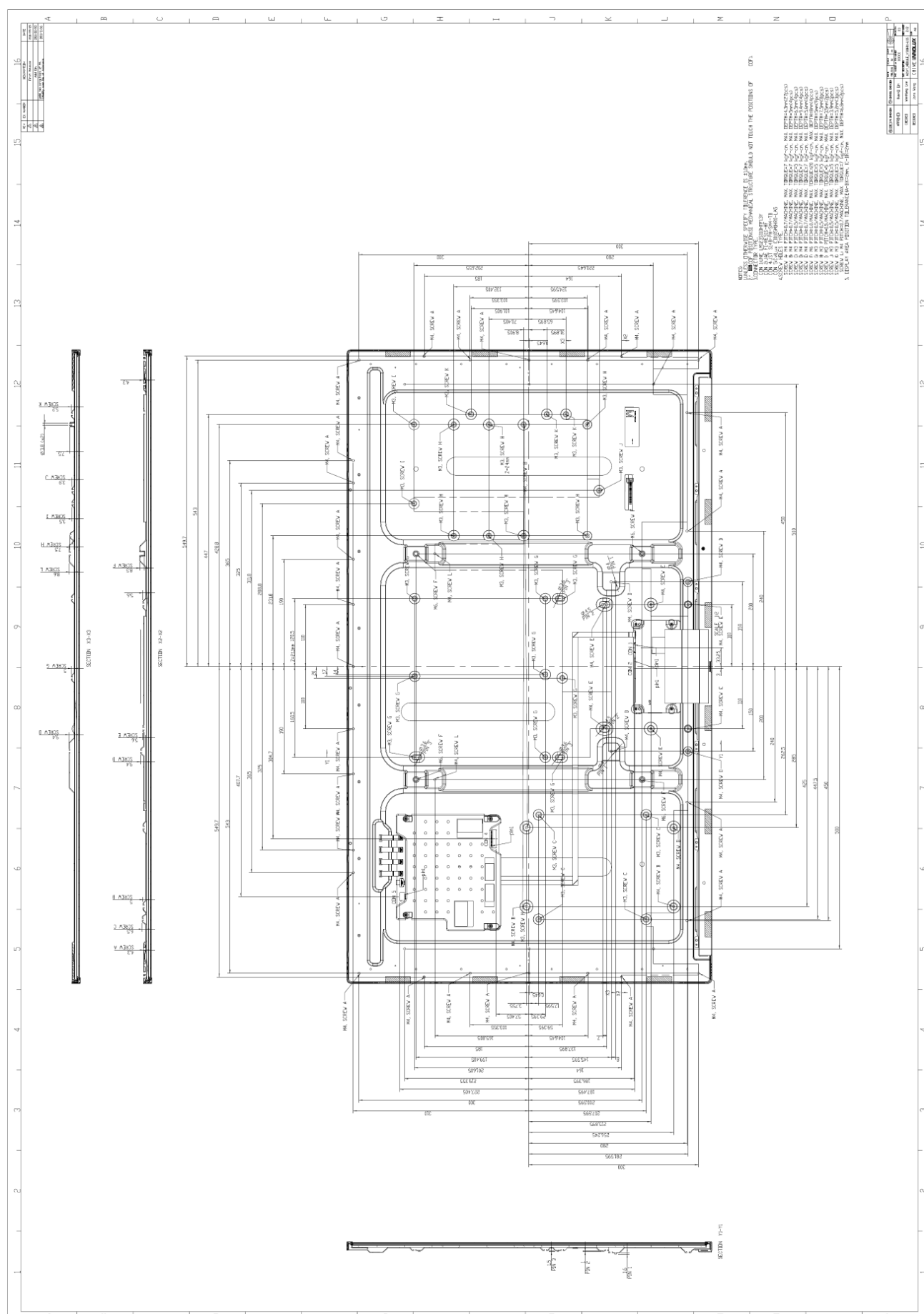
The LCD module should be certified with safety regulations as follows:

Regulatory	Item	Standard
Information Technology equipment	UL	UL60950-1:2006 or Ed.2:2007
	cUL	CAN/CSA C22.2 No.60950-1-03 or 60950-1-07
	CB	IEC60950-1:2005 / EN60950-1:2006+ A11:2009
Audio/Video Apparatus	UL	UL60065 Ed.7:2007
	cUL	CAN/CSA C22.2 No.60065-03:2006 + A1:2006
	CB	IEC60065:2001+ A1:2005 / EN60065:2002 + A1:2006+ A11:2008

If the module displays the same pattern for a long period of time, the phenomenon of image sticking may be occurred.

11. MECHANICAL CHARACTERISTIC





Version2.3

48

Date 17 Nov.2011

The copyright belongs to CHIMEI InnoLux. Any unauthorized use is prohibited

Appendix A

Local Dimming demo function

A.1 I2C address and write command

Device address: 0xe0

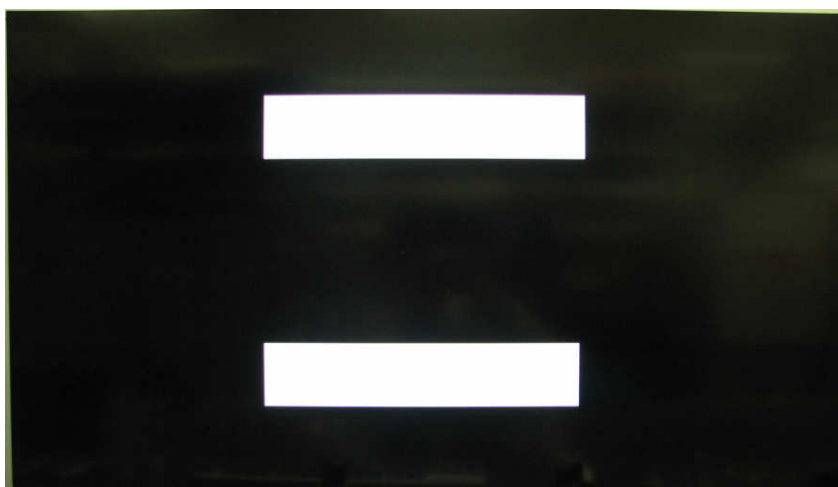
Register address: 0x65

Command data: 0x16 0x00 0x00 0x00 0x00 0x01

Preamble data: 0x26 0x38

I2C data: 0xe0 0x26 0x38 0x65 0x16 0x00 0x00 0x00 0x00 0x01

Note 1: Local Dimming demo OFF



Note 2: Local Dimming demo ON



A.2 I2C timing

Symbol	Parameter	Min.	Max.	Unit
$t_{\text{SU-STA}}$	Start setup time	250	-	ns
$t_{\text{HD-STA}}$	Start hold time	250	-	ns
$t_{\text{SU-DAT}}$	Data setup time	80	-	ns
$t_{\text{HD-DAT}}$	Data hold time	0	-	ns
$t_{\text{SU-STO}}$	Stop setup time	250	-	ns
t_{BUF}	Time between Stop condition and next Start condition	500	-	ns

